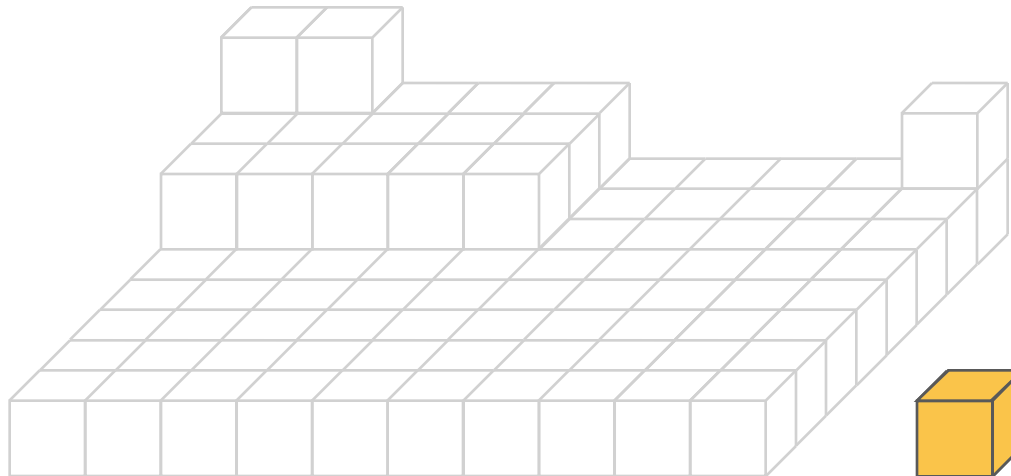












Thin film solar cells

Erik Stensrud Marstein
Department for Solar Energy
Institute for Energy Technology (IFE)



UNIK 4450/9450 – Schedule

 30/8 Solar cell fundamentals
 6/9 Solar cell efficiency
 13/9 Semiconductor theory
 20/9 Generation
 27/9 Recombination and lifetime
 4/10 Silicon
 11/10 Junctions

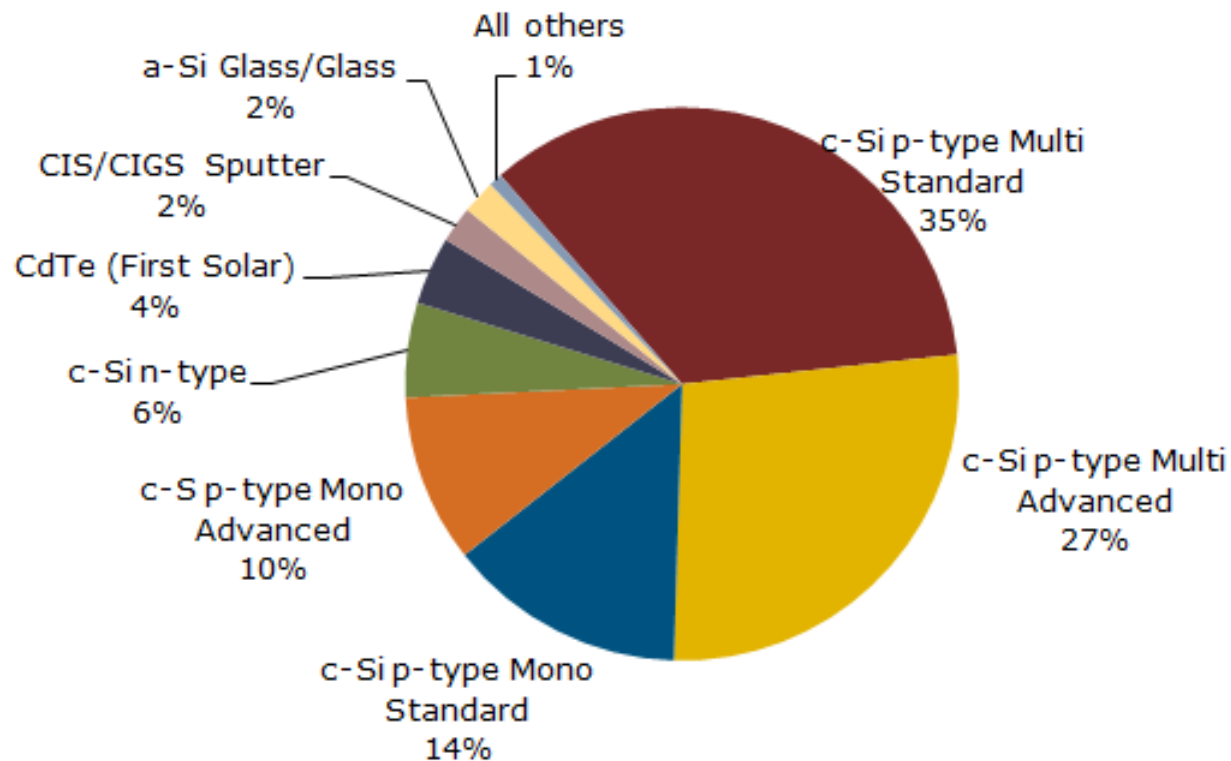
 18/10 Solar cells
 25/10 Silicon solar cells I (@IFE)
 1/11 Silicon solar cells II
• 8/11 Light management
• 15/11 Alternative solar cells
• 29/11 Solar modules & systems
• 6/12 Q&A

• Oral exam December 12th

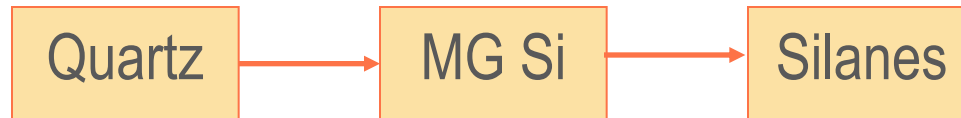
Overview

- Thin film deposition
- The effect of microstructure
- Silicon-based thin film solar cells
- Alternative thin film solar cells
 - CIGS and it's relatives
 - CdTe
 - Recent developments

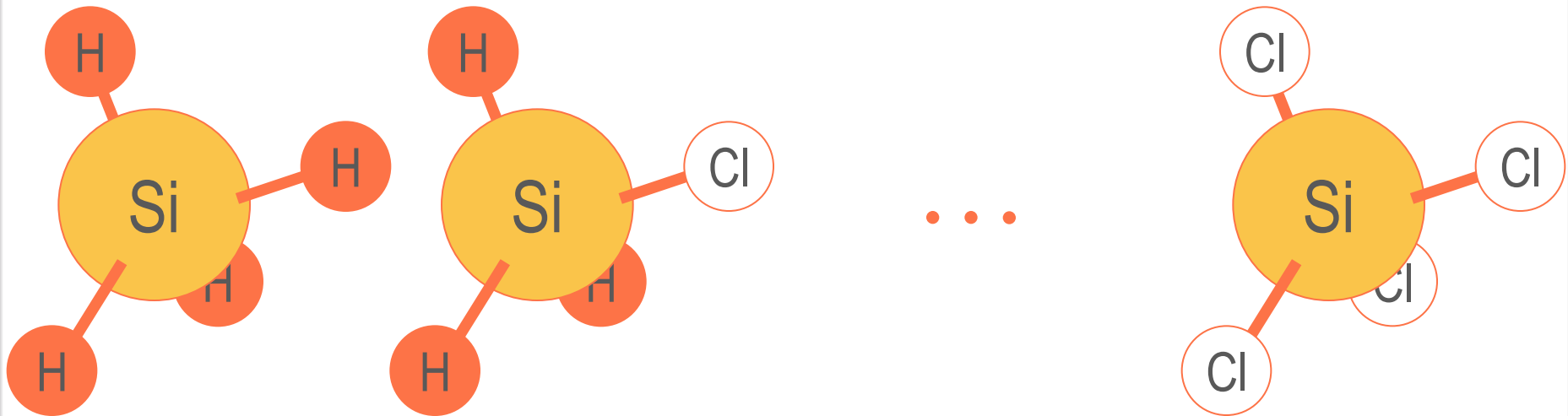
Solar cells anno 2014



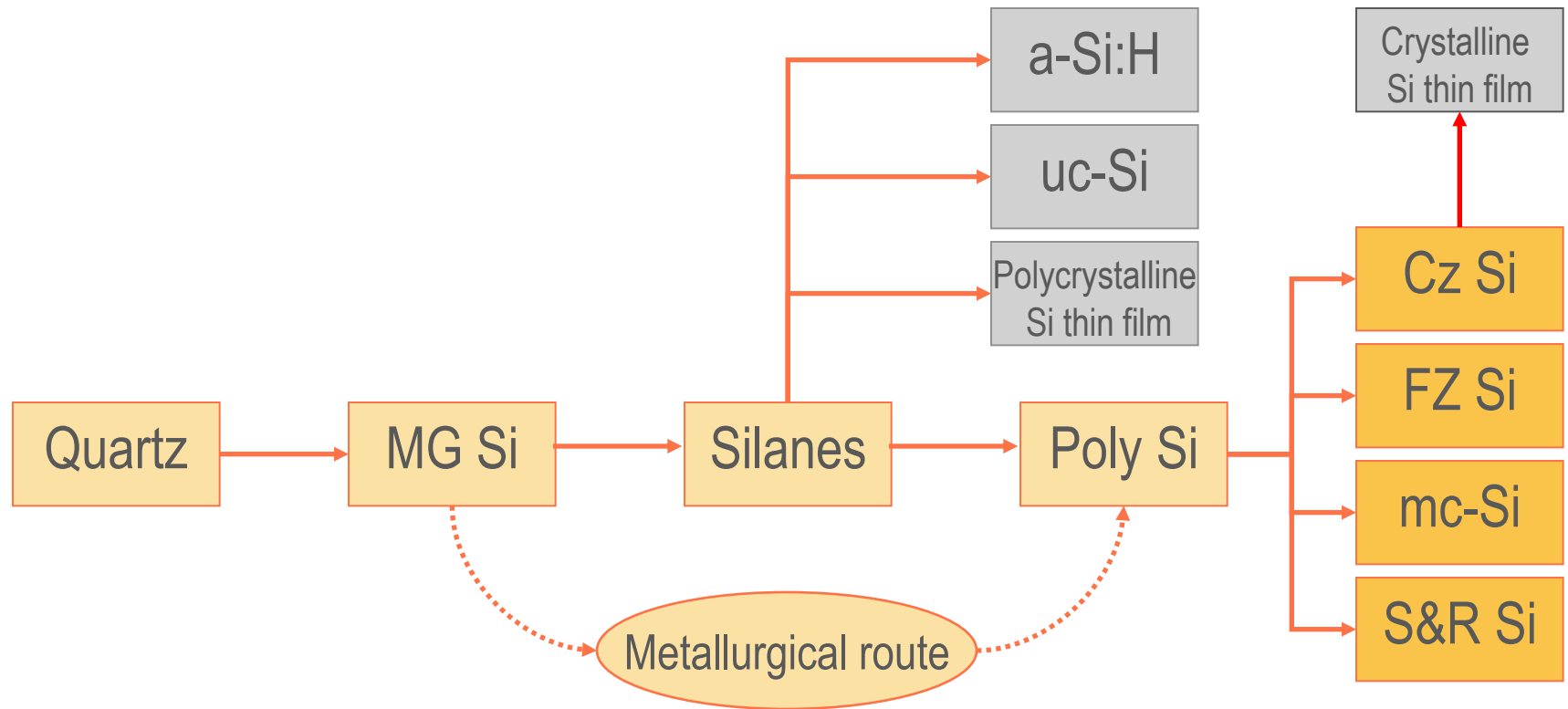
Silicon-based solar cells



Silanes

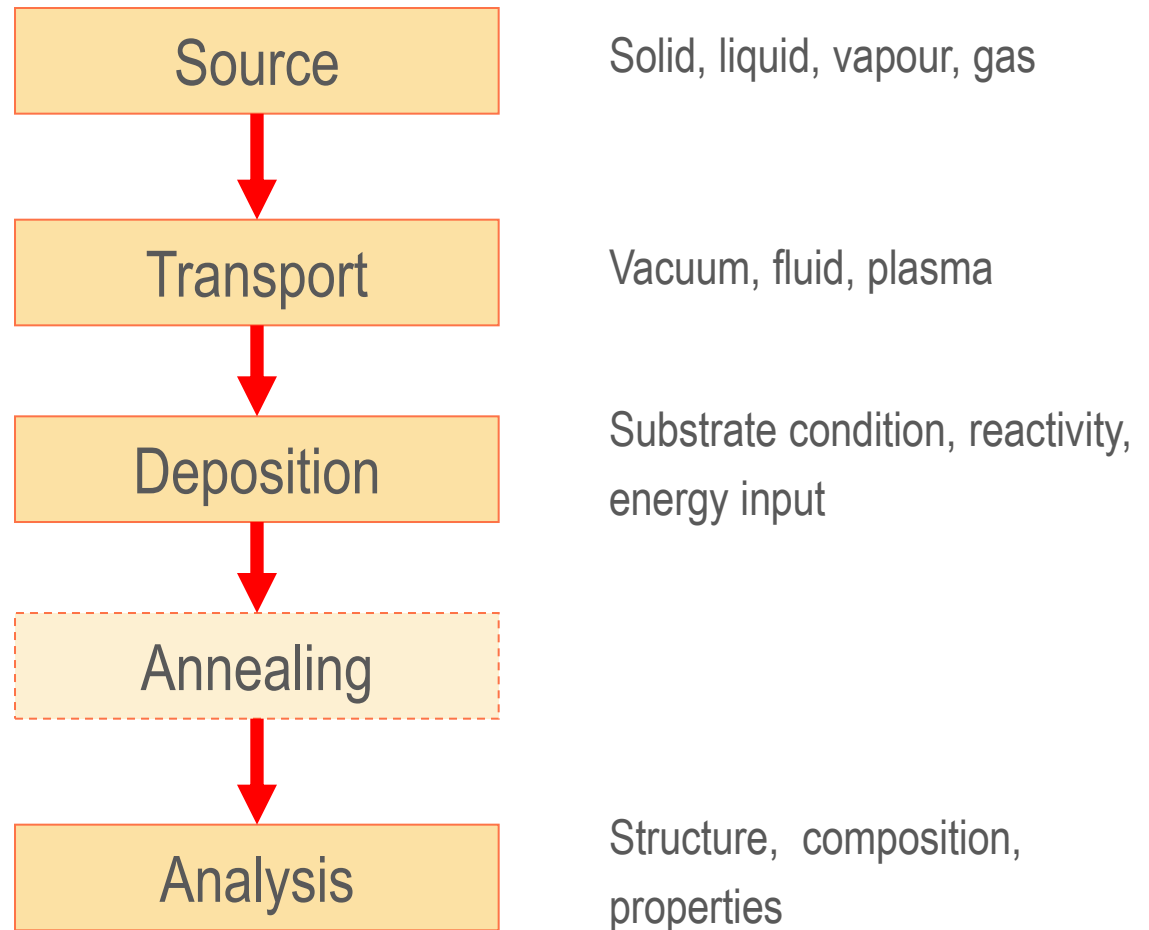


Silicon-based solar cells



Thin film deposition

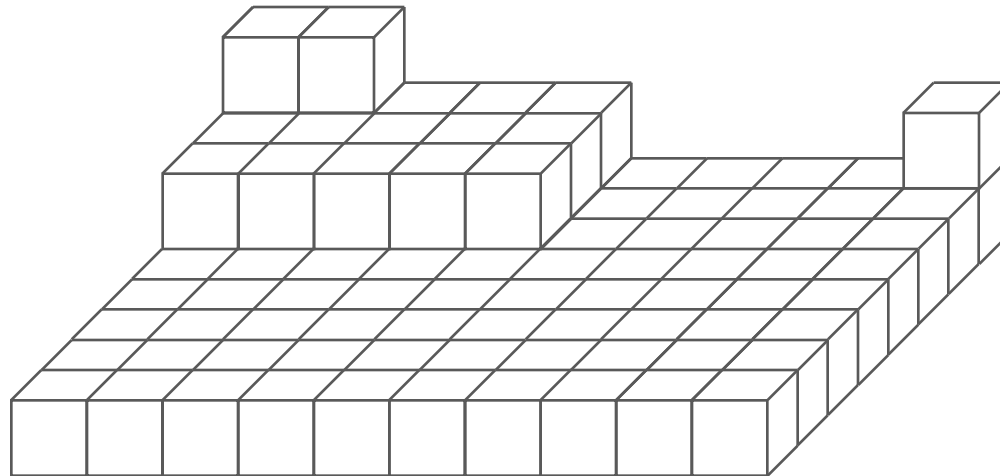
Thin film deposition



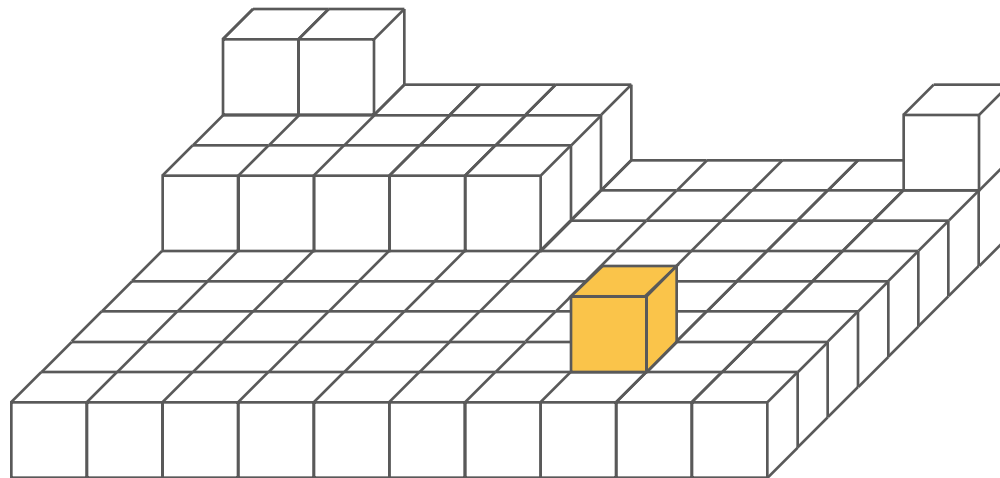
Deposition methods

- Evaporation
 - Thermal evaporation
 - E-beam evaporation
- Sputtering
 - Reactive sputtering
- Pulsed laser deposition
- Chemical vapour deposition (CVD)
 - Plasma-enhanced CVD (PECVD)
 - Metal-organic CVD (MOCVD)
- Molecular beam epitaxy
- Atomic layer deposition/epitaxy
- Printing
 - Screen printing
 - Ink-based printing
- ...

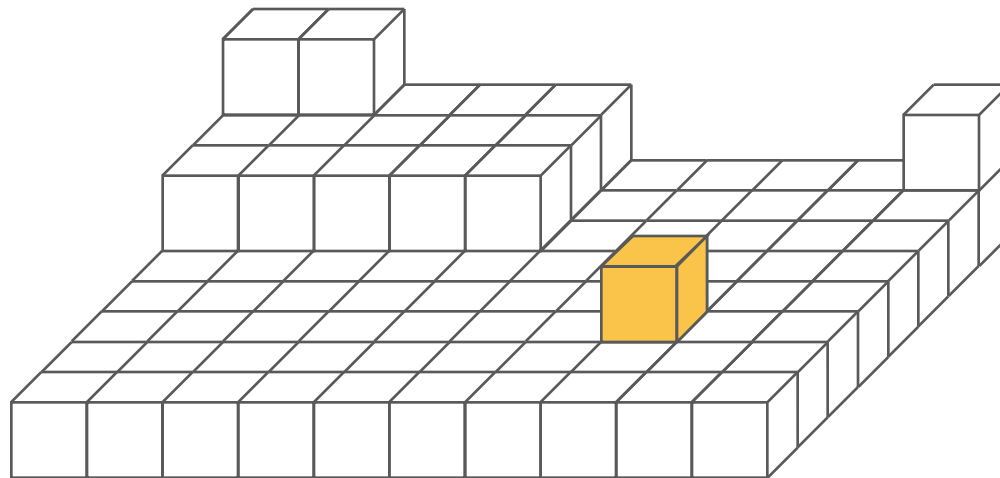
Thin film deposition



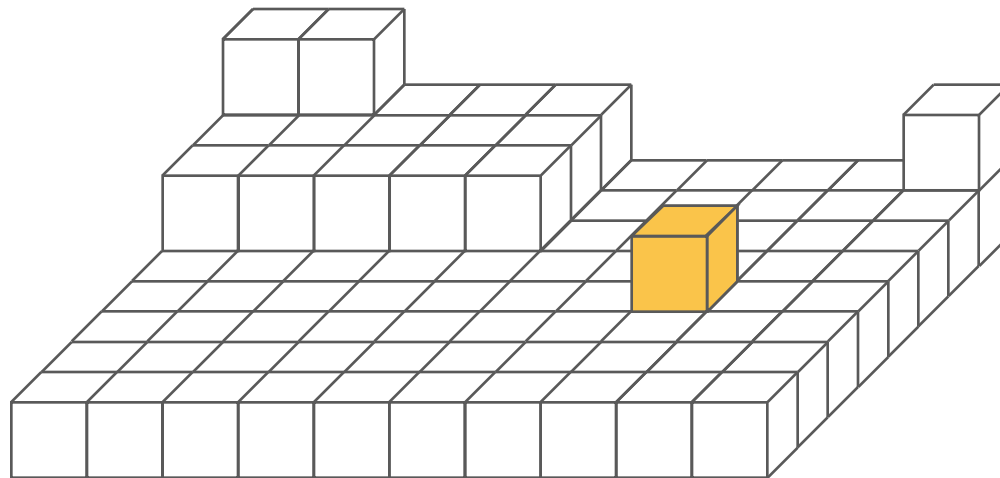
Thin film deposition



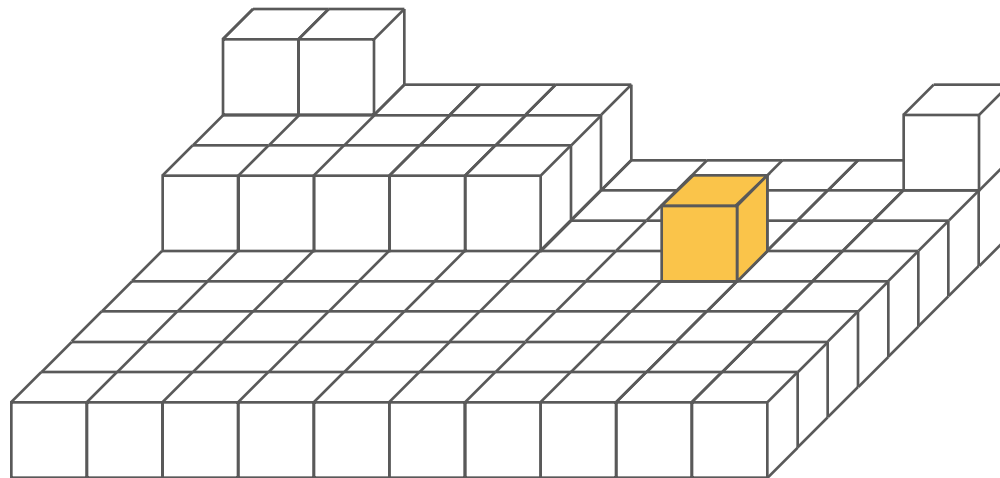
Thin film deposition



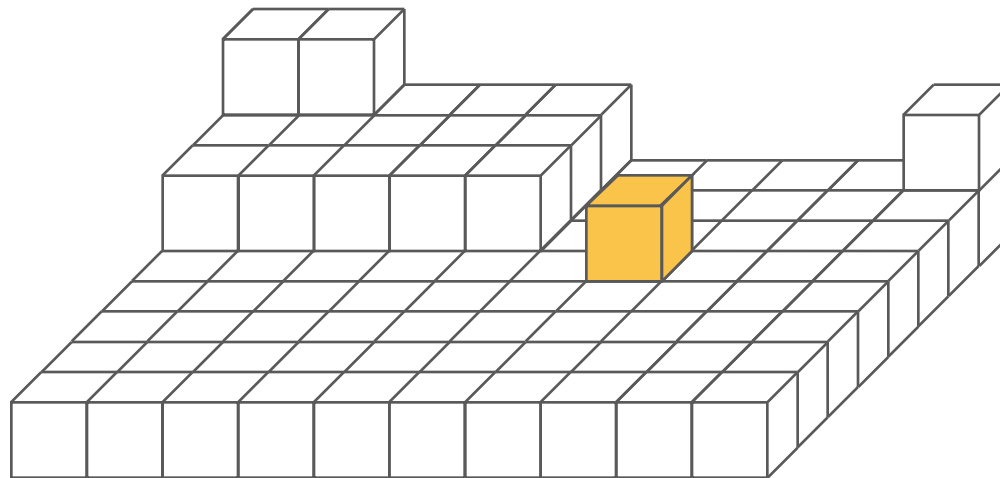
Thin film deposition



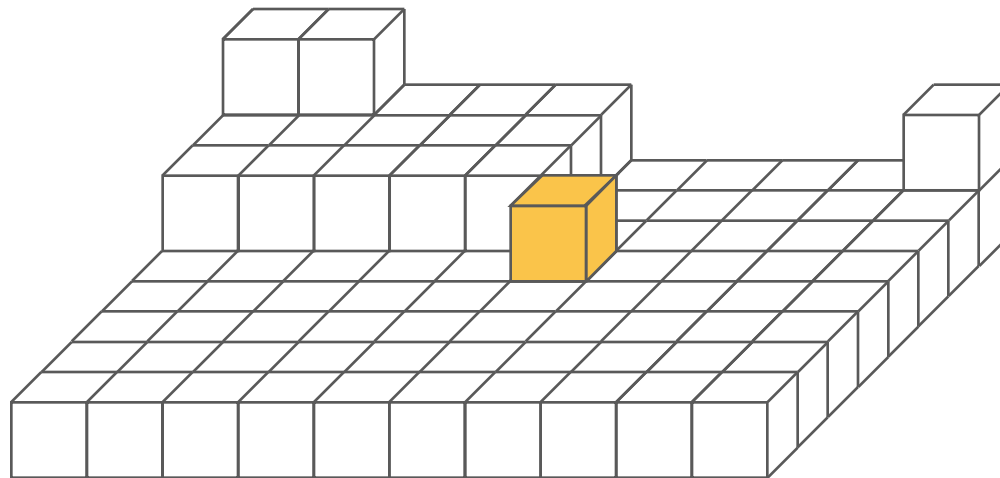
Thin film deposition



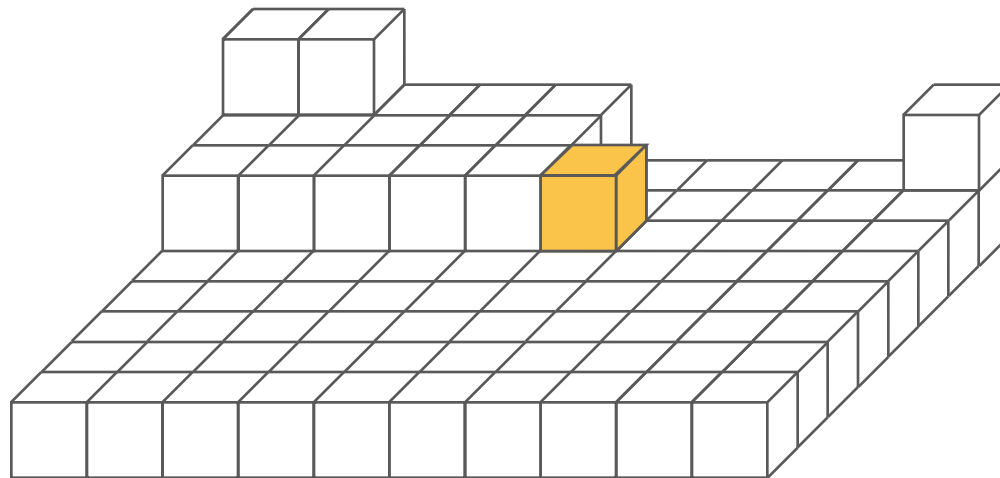
Thin film deposition



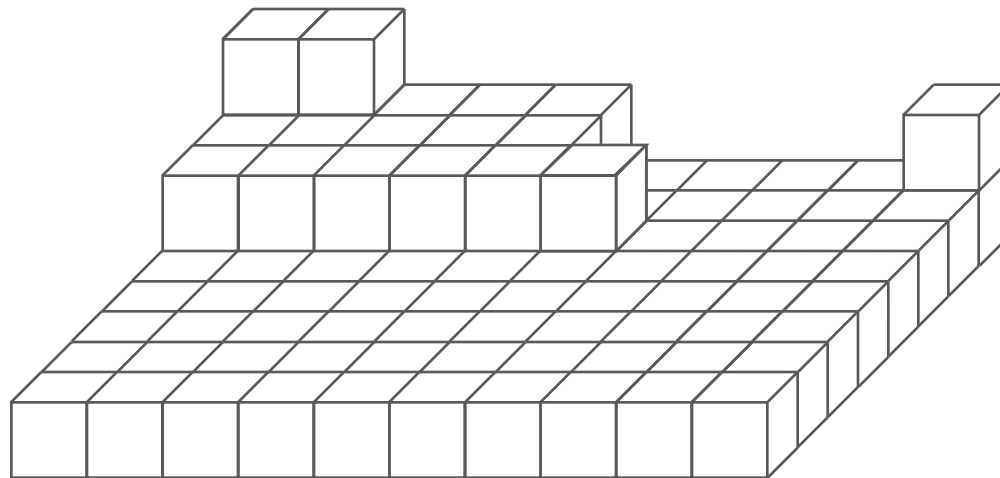
Thin film deposition



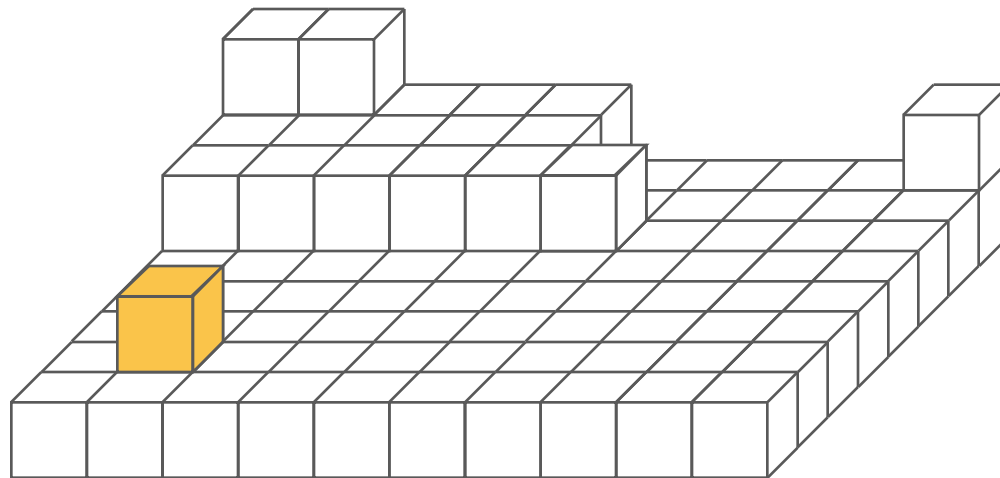
Thin film deposition



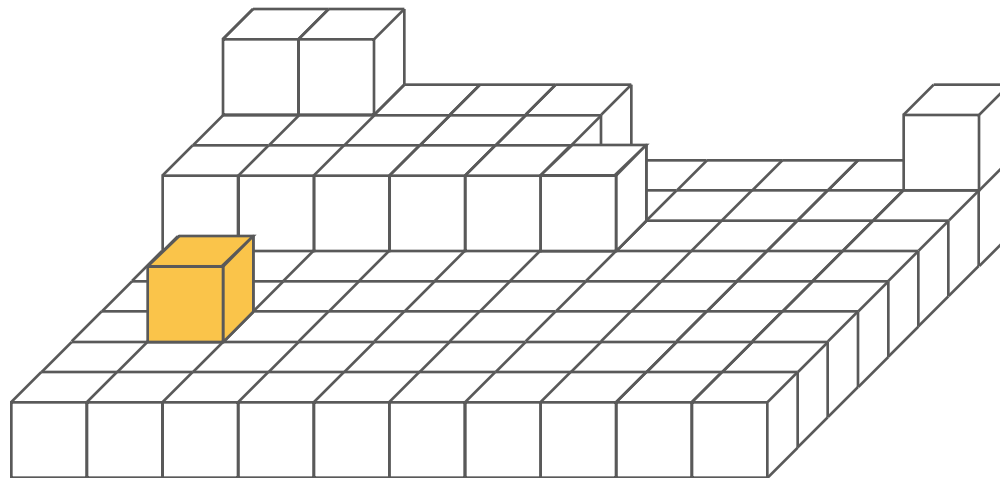
Thin film deposition



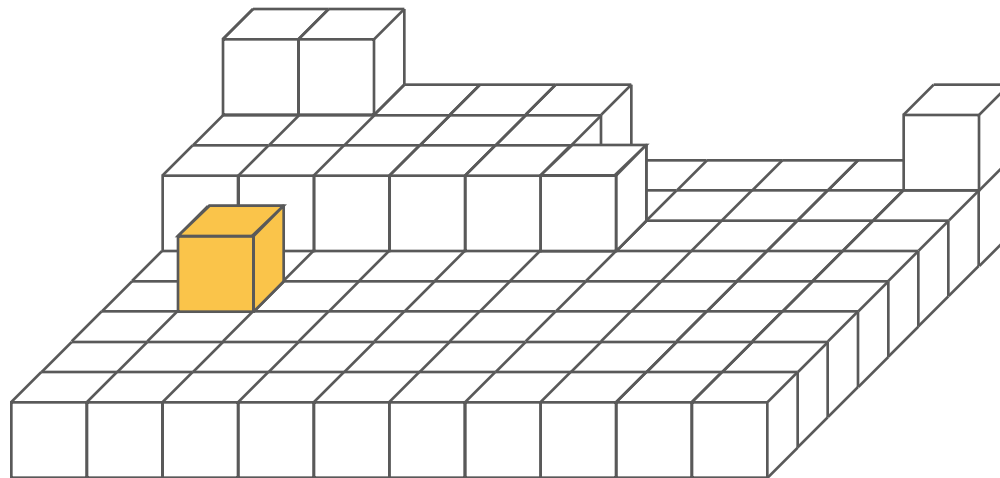
Thin film deposition



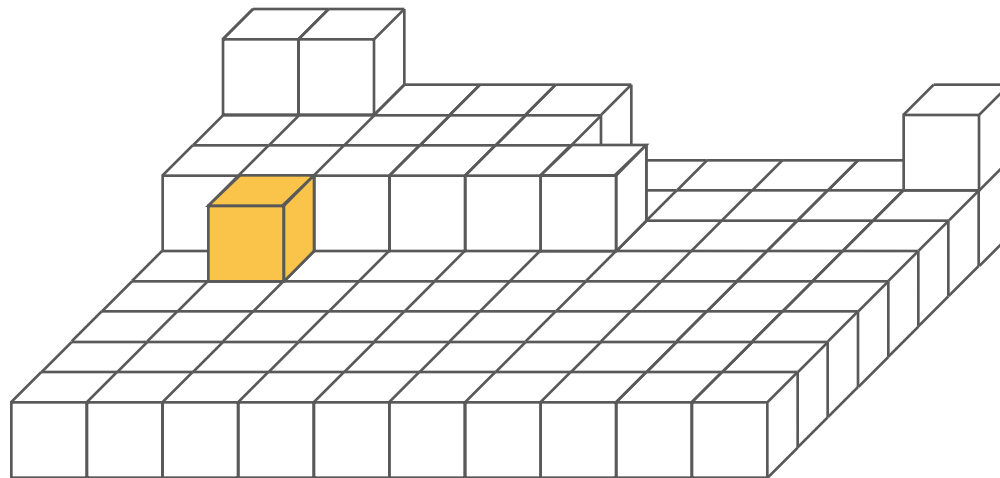
Thin film deposition



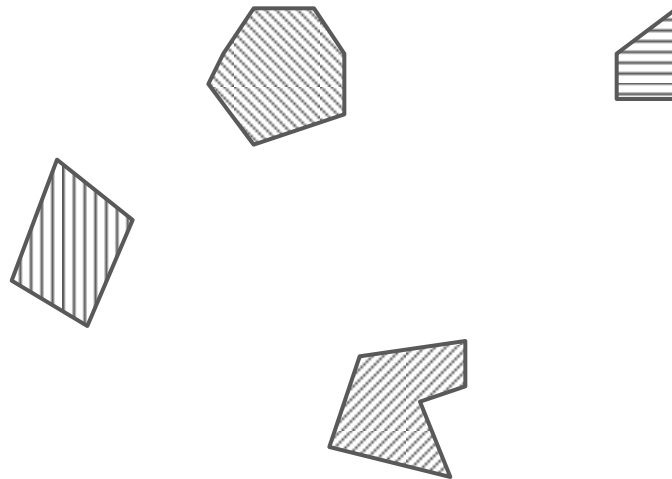
Thin film deposition



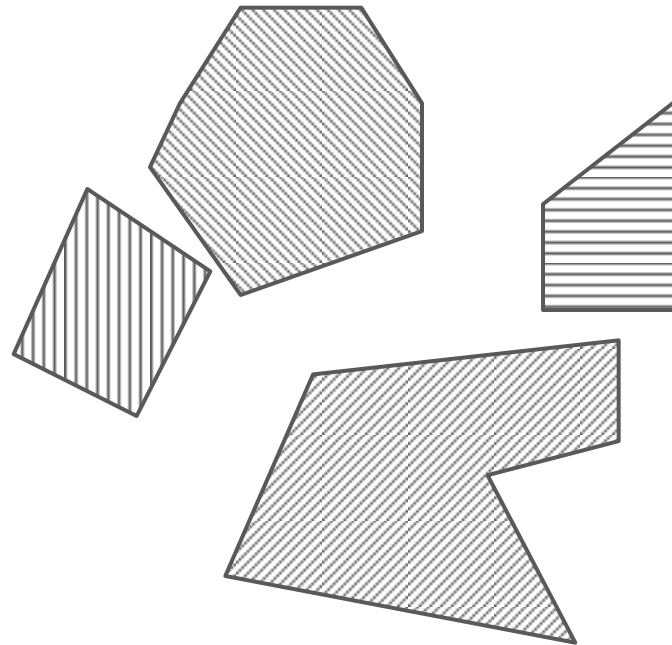
Thin film deposition



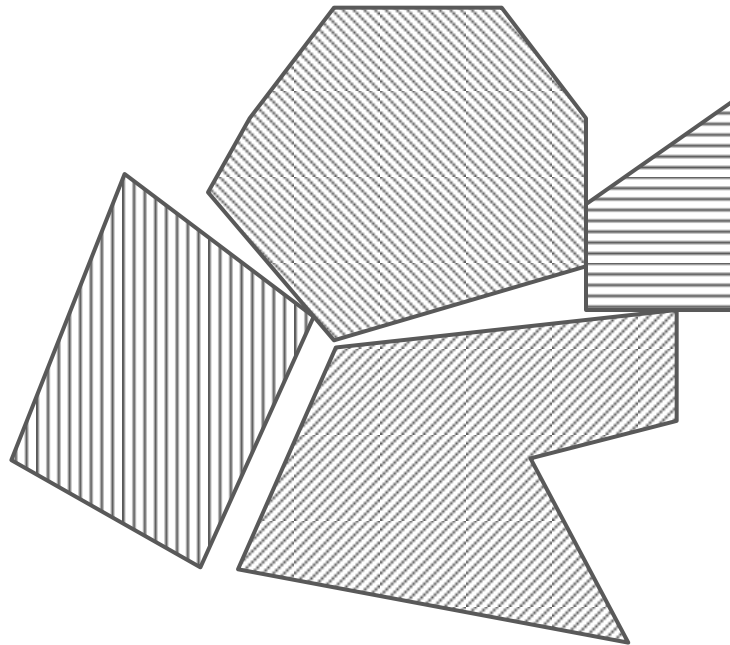
Thin film deposition



Thin film deposition



Thin film deposition



Microstructure

- The microstructure of a thin film material is ***strongly*** dependent of the deposition conditions!
- Phenomena:
 - Transport
 - Adhesion, bonding, binding
 - Desorption
 - Nucleation
 - ...
- Parameters:
 - Concentrations of precursors/source gases
 - Temperature
 - Total gas flow rates
 - Reactant gas flow rates
 - RF power
 - ...

...first you take a substrate

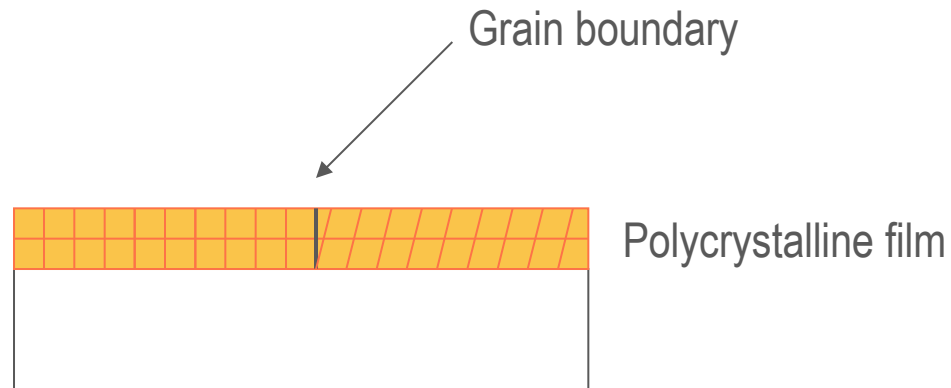
Substrate

Epitaxial/crystalline thin films



Crystalline film

Polycrystalline thin films



Columnar growth/polycrystalline films



Polycrystalline film

Amorphous thin films



Amorphous thin film

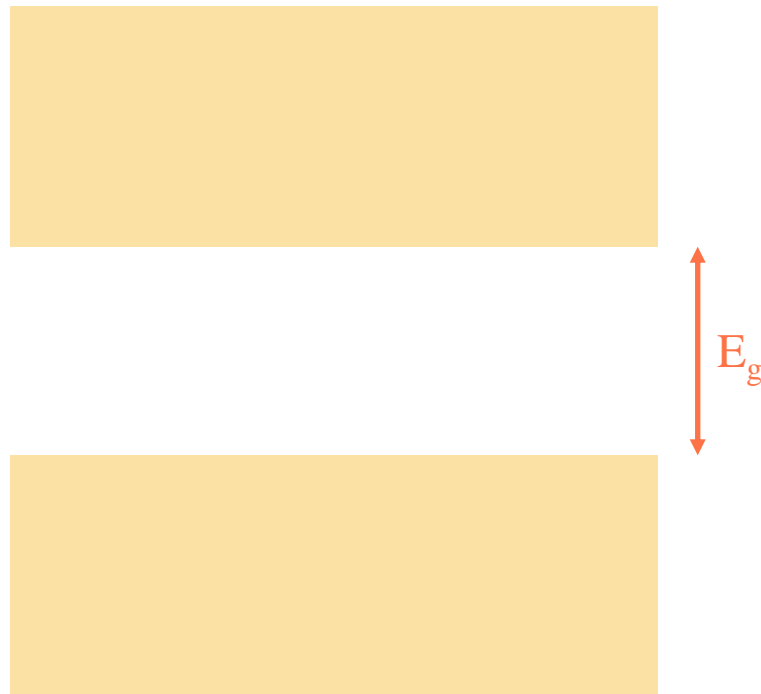
Microstructure

- Textbook semiconductor physics in its simplest form assumes perfect (i.e. crystalline) semiconductors
- Microstructure effects can include
 - Complete change of overall material properties (a-Si \neq c-Si)
 - Changed charge carrier mobilities
 - Changed recombination rates
 - Grain boundary effects on transport and recombination
 - Staebler-Wronskij degradation
 - ...

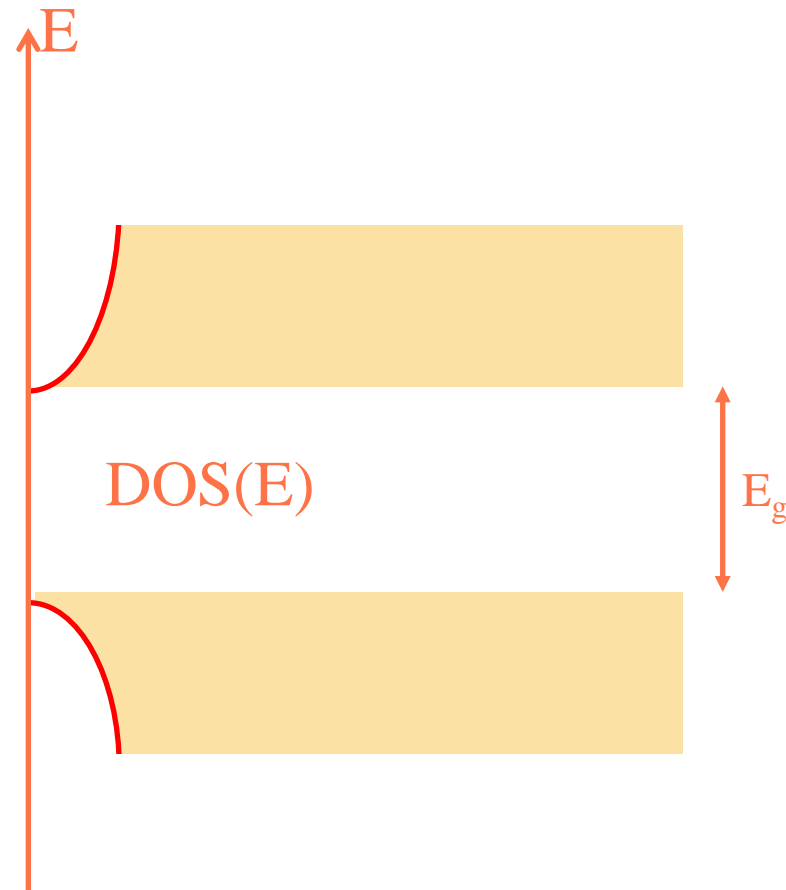
Microstructure



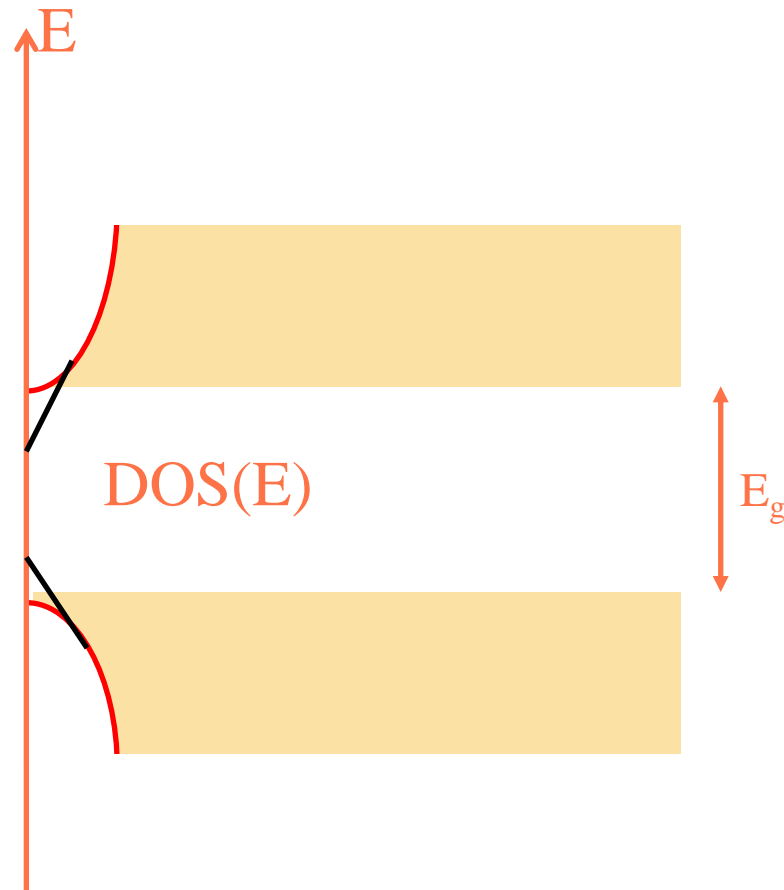
Microstructure



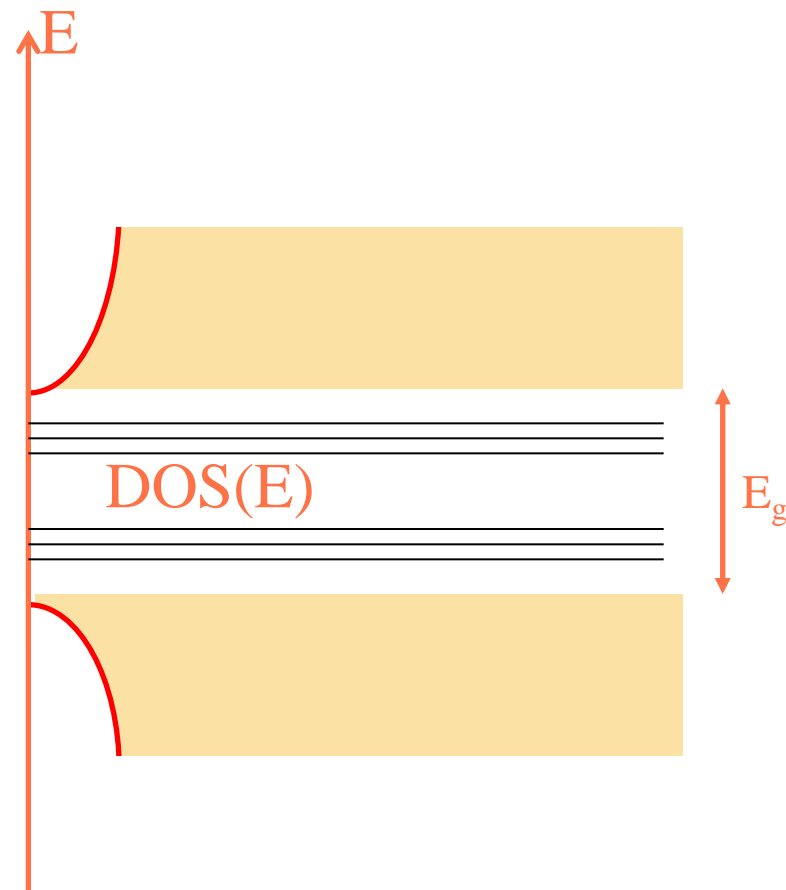
Microstructure



Urbach tails

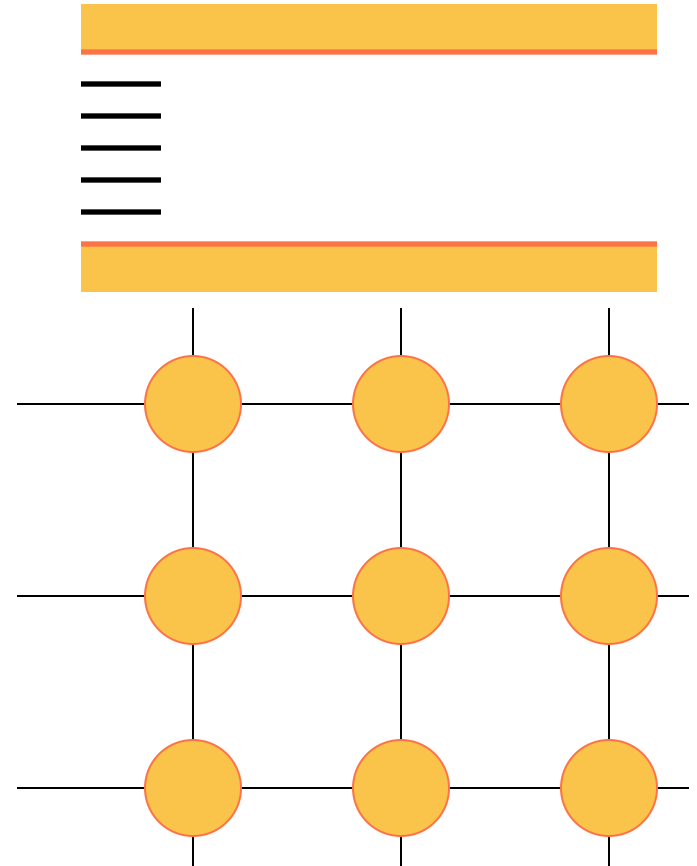


Defect bands



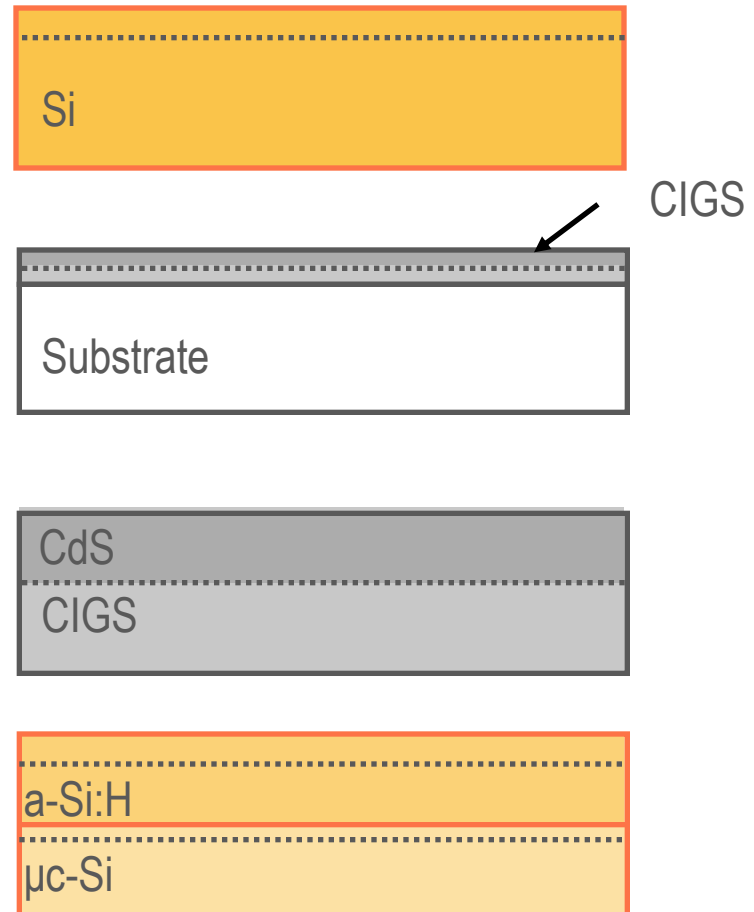
Surfaces and interfaces

- Surfaces and interfaces are likely to contain defects
 - Intrinsic defects: defects due to an interrupted crystal structure
 - Extrinsic defects: e.g. Impurities adsorbed at the interface
- These defects often introduce states in the band gap
- These defects are localized at the interface and can trap charge
 - Will influence potential distribution across interface
 - Will affect band bending across interface



Solar cell technologies

- Homojunction solar cells
 - Crystalline silicon
- Thin film cells
 - Amorphous Si (a-Si:H)
 - Composite semiconductors
 - Cu(In,Ga)Se₂ (CIGS)
 - CdTe
- Heterojunction solar cells
- 3rd generation solar cells
 - Tandem solar cells

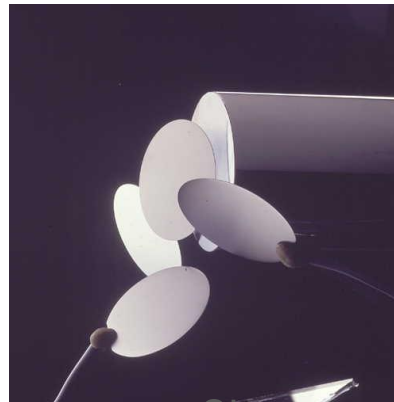


Homojunctions

- Materials
 - Silicon
 - Compound semiconductors
- Advantages
 - Efficient
 - Relatively cost-efficient
 - Mature technology
- Disadvantage
 - Material consumption

n-type semiconductor

p-type semiconductor



sc-Si



mc-Si

Heterojunctions

- Materials

- a-Si on Si
- Most thin film solar cells
 - CdS on CdTe or CIGS

n-type semiconductor

p-type semiconductor

- Advantages

- Potentially very efficient

- Disadvantages

- Metallurgical interface

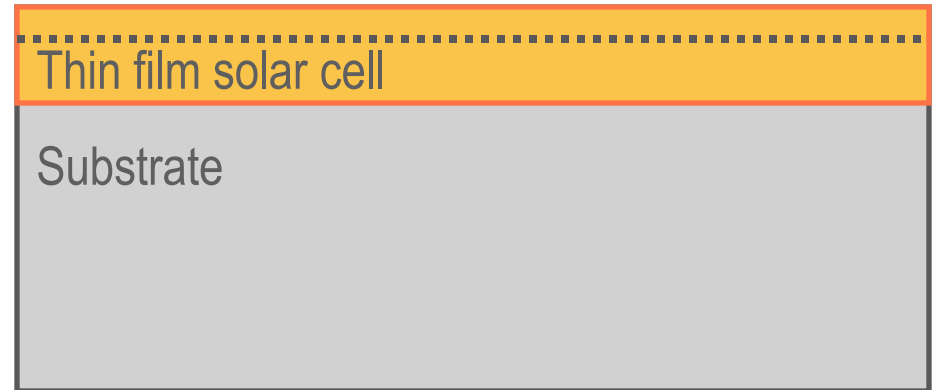
Thin film solar cells

- Materials

- Si (a-Si, sc-Si)
- CdTe
- CIS/CIGS (Cu(In,Ga)Se_2)

- Advantages

- Low material consumption
- Potentially cost-effective



- Disadvantages

- Material quality
- Material issues (In, Cd)
- Somewhat immature technology

Clever student question:

If deposited materials often are of low quality, why bother with thin film solar cells?

Motivation

- The **big** challenge for the photovoltaic industry is to make solar electricity cost-competitive
- Currently, substrate-based solar cells made from crystalline silicon dominate the solar cell
 - “First generation solar cells”
 - Strengths: infrastructure, performance, material availability
 - Weaknesses: high material consumption (“thick” substrates, kerf losses), relatively expensive materials, high energy consumption
- Thin film solar cells might reduce costs and energy expenditure due to a significantly lower consumption of expensive materials

... so what is all the fuzz about?

- Dagens næringsliv 27/12 2006:
 - Lars Stolt, Solibro: "Skal sette REC i skyggen" DN 27/12 2006
 - "Current REC solar cells will be out of the competition in 15 years"
 - Technology now in production under Q-modules
- Flexible CIGS submodule reaches 15.9% efficiency
 - April 2010
- Is the silicon era coming to an end?

Worried about the competition?

Q.CELLS

Core Business

- World's second largest cell producer
- Forecast 2006: Production 255 MW_p
Sales EUR 525 million
- Strategy: Growth and cost reduction
- Strong focus on R&D/new technologies
- New cell concepts and thin film modules



New Technologies

EverQ GmbH

- String Ribbon technology
- Q-Cells share: 33%

CSG Solar AG

- Thin-film technology: Crystalline Silicon on Glass
- Q-Cells share: 23%

Brilliant 234. GmbH

- Micromorph silicon thin-film technology
- Q-Cells share: 100%

VHF-Technologies SA

- a-Si roll-to-roll on film ("flexcell")
- Q-Cells share: 15 to 51%

Calyxo GmbH

- Thin-film technology
- Q-Cells share: 100%

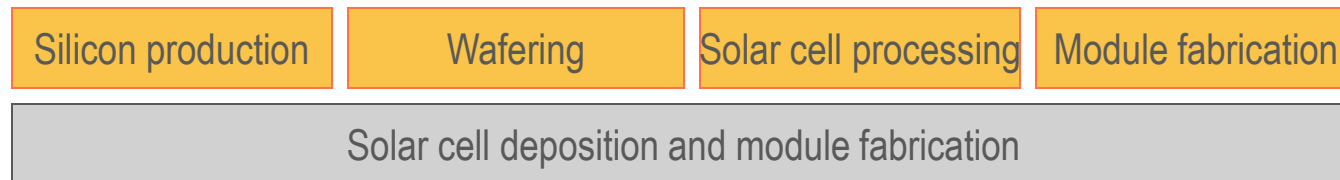
NewCo GmbH

- Thin-film technology under consideration

Q-Cells

The benefits of thin film solar cells

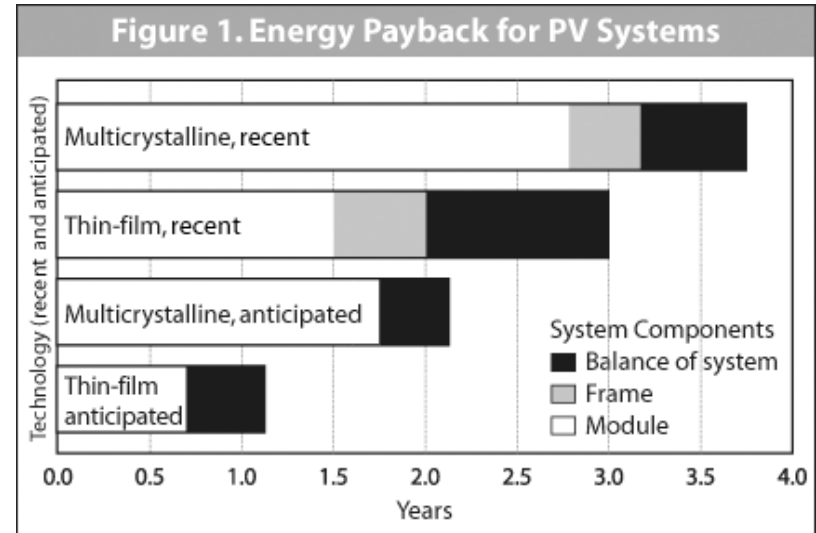
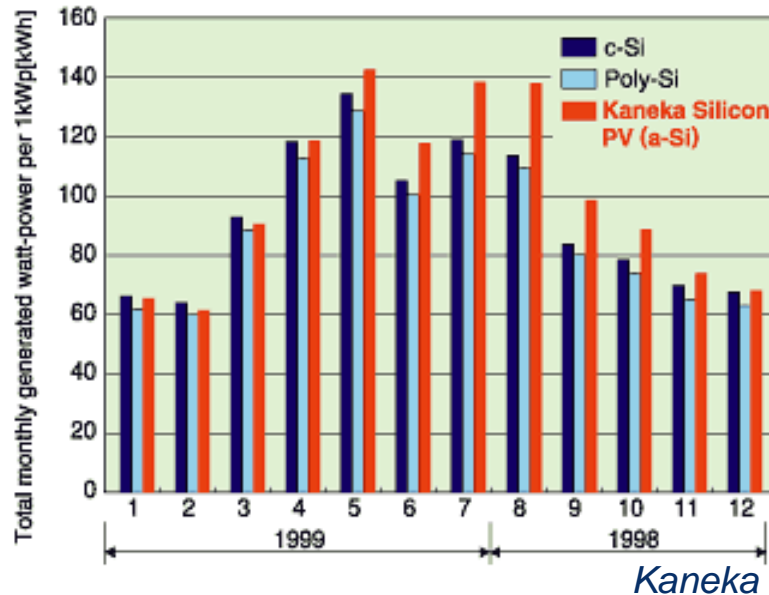
- Potential for drastic cost reductions for solar electricity
 - Less consumption of expensive materials ($\sim 1\text{ }\mu\text{m}$ cell vs $\sim 250\text{ }\mu\text{m}$ cell)
 - Solar cell efficiencies are still increasing both in laboratories and production
 - Integrated production of solar cell modules



- Scribing and creative use of interconnections allow for flexibility in module voltages
- Many available substrates

The benefits of thin film solar cells

- Lower energy payback times
- Good field performance when compared with nominal output



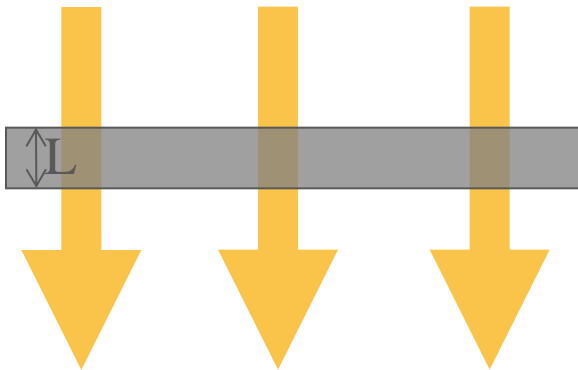
The challenges of thin film solar cells

- All of the technologies to be presented is faced with one or more of the following challenges:
 - Immature technologies
 - Throughput / deposition rates
 - Short module lifetimes
 - Low availability of esoteric materials
 - In, Ga ...
 - Cadmium usage
 - Typically low **module** efficiencies compared with Si
 - mc-Si: 15 – 18%
 - sc-Si: 17 – 20%
 - "high-end" sc-Si: 20 – 23%

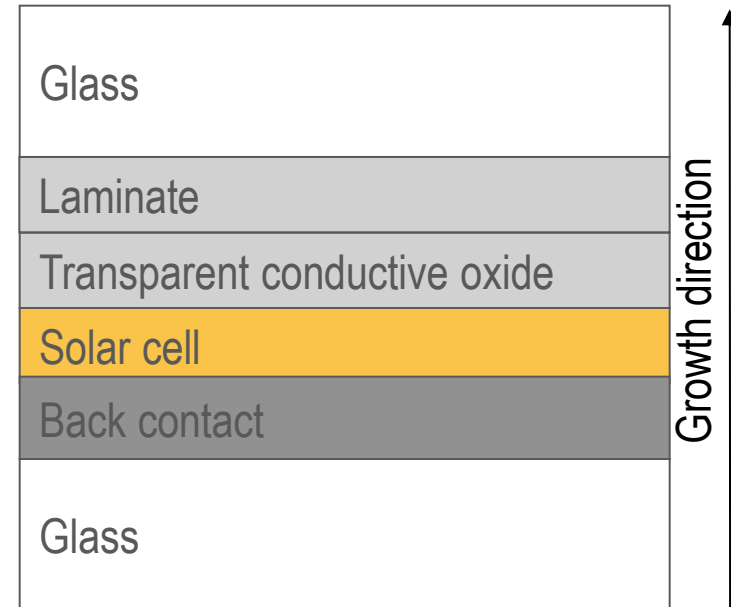
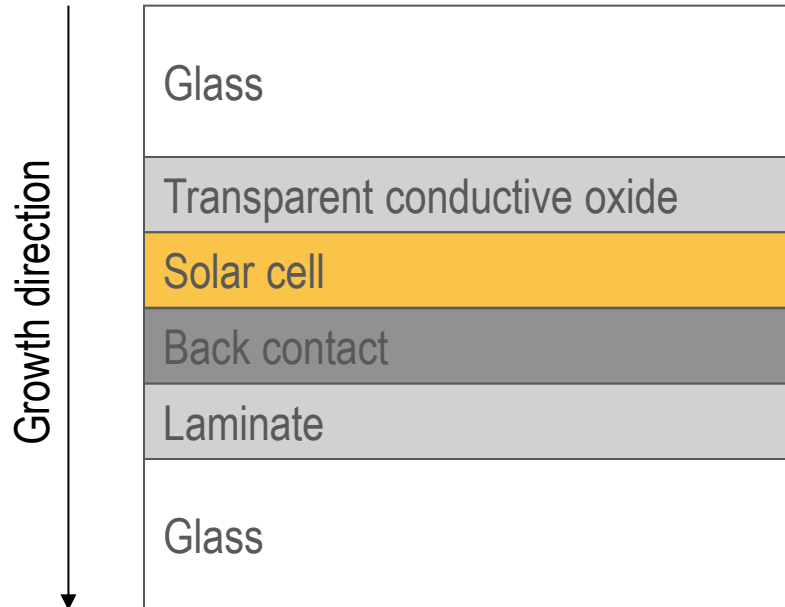
Material requirements for thin film solar cells

- Strong absorption vital
- Diffusion lengths can be shorter
- Surface passivation can be important
- Interface recombination must be low

Material requirements for thin film solar cells



Substrates/superstrates



Silicon-based thin film solar cells

Amorphous silicon thin film

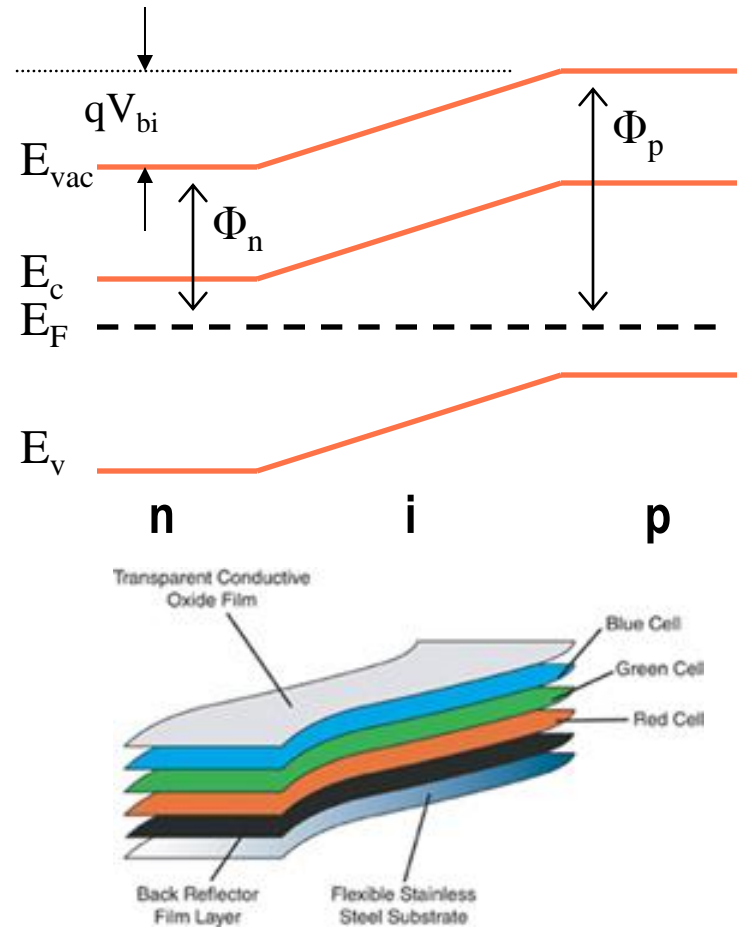
- The most developed of the thin film technologies
- Thin films of a-Si are produced using CVD of silane
 - Usually PECVD or "hot wire" CVD
- Wide selection of substrates
 - Glass, metal sheets, plastics...
- High H content required in order to passivate defects
- Solar cell efficiency is severely degraded during illumination
 - Staebler-Wronski effect



www.uni-solar.com

Amorphous silicon thin film

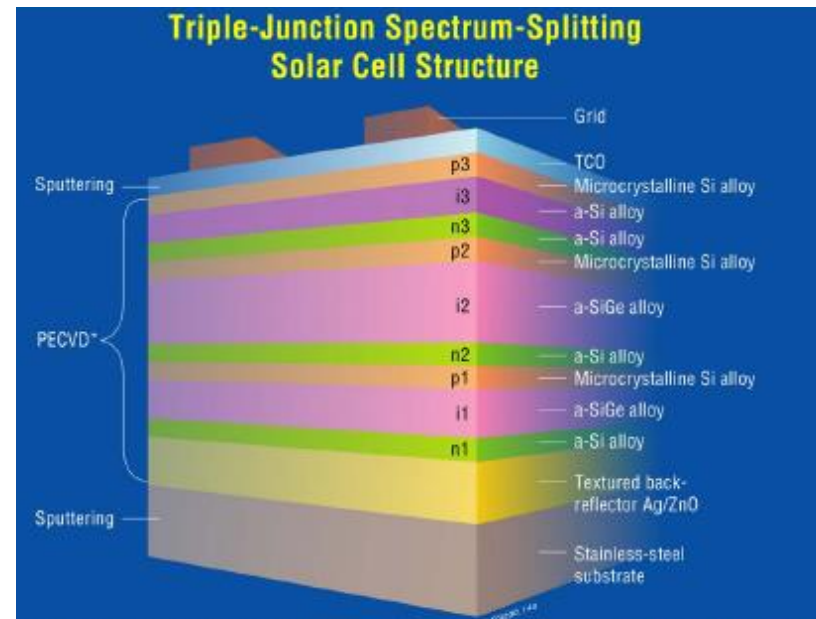
- Cell design challenges
 - Doping a-Si gives large recombination losses
 - Cells must have a certain thickness in order for sufficient absorption to occur
 - Conventional p-n homojunction structures not suitable
- Good solar cell performance is made by using p-i-n structures or tandem solar cells
 - a-Si and $\mu\text{c-Si}$ or a-SiGe
 - More complex cell fabrication!



www.uni-solar.com

Amorphous silicon thin film

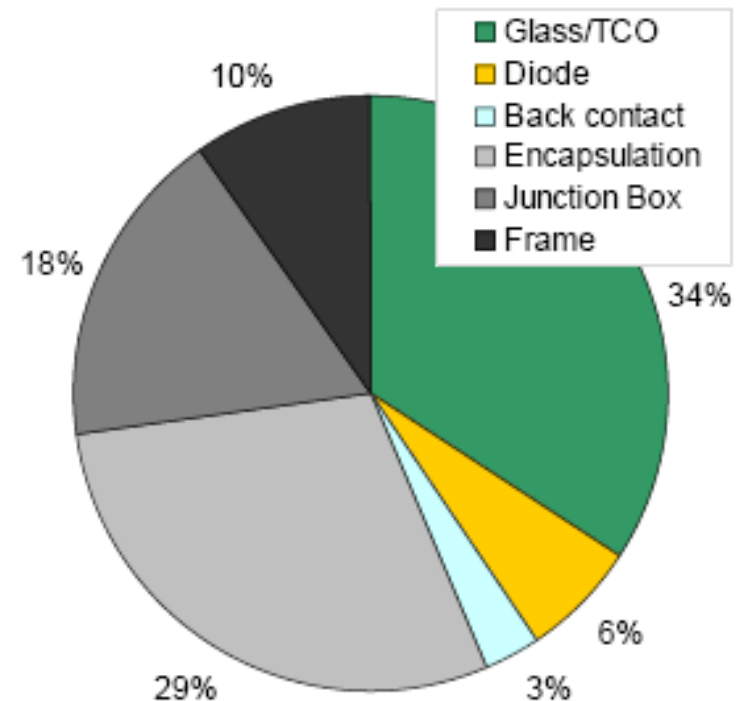
- Typical module efficiency
 - $\sim 6 - 8 \%$
- Record efficiency: 10.2 % (AIST)



www.uni-solar.com

Microcrystalline silicon thin film

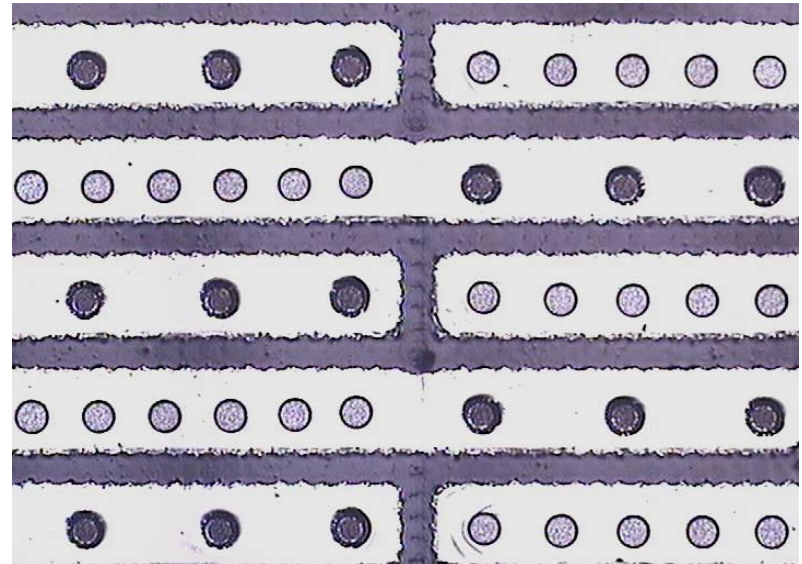
- Builds on experience with a-Si solar cells
- Main idea: to combine a-Si advantages with the stability and performance of crystalline Si
 - Best efficiencies
 - $\mu\text{c-Si}$: 10%
 - a-Si/ $\mu\text{c-Si}$: 14%
- $\mu\text{c-Si}$ can also replace a-SiGe in a-Si tandem solar cells
 - Use of expensive germane is avoided
 - Must have thick $\mu\text{c-Si}$ and thinner a-Si due to absorption and stability, hence deposition rates are an issue
- Efficiency record: 11.9% (AIST)



Brilliant234/Q-cells

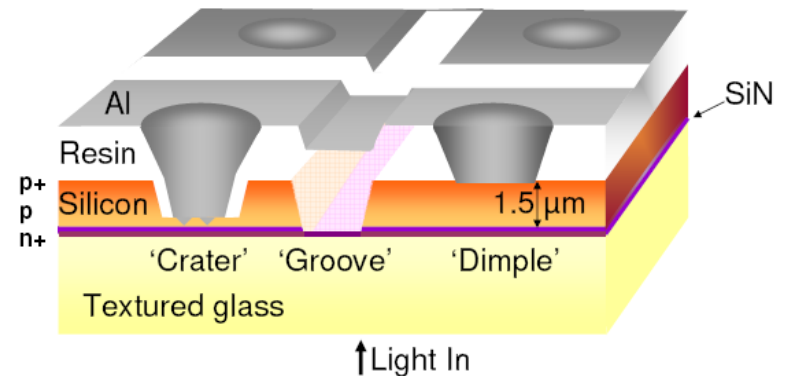
Polycrystalline silicon thin film

- A further improvement in Si material quality
 - Larger Si grains than in $\mu\text{c-Si}$
- Module efficiencies:
 - Approaching 10 %
- Research groups
 - IMEC, UNSW



Polycrystalline silicon thin film

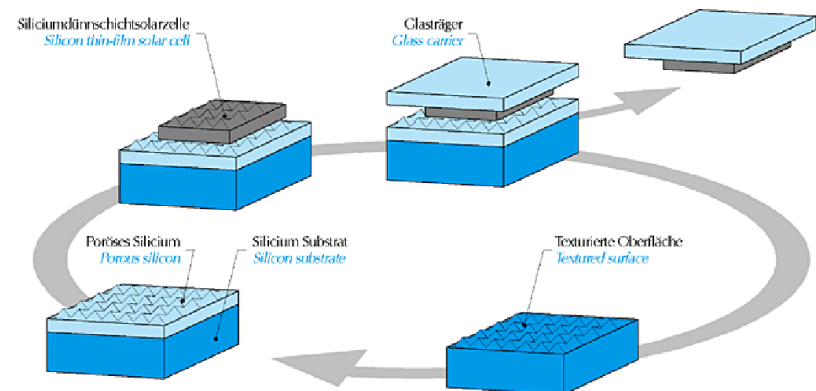
- Example process: CSG Solar
 1. Use a textured borosilicate glass substrate
 2. Deposit SiN with PECVD
 3. Deposit n+/p/p+ Si structure with PECVD
 4. Crystallise Si
 5. Anneal defects
 6. Hydrogen passivation
 7. Laser scribing (cell separation)
 8. Resin coating
 9. Opening of resin and selective etching of Si (two steps: front and rear contact)
 10. Deposit Al contacts
 11. Laser pattering of contacts



CSG Solar

Monocrystalline silicon thin film

- A thin film solar cell that maintains all benefits of sc-Si
- Based on lift-off techniques
 1. A porous silicon double layer is formed on a silicon substrate
 2. Silicon is epitaxially grown atop the porous film
 3. The silicon film thus grown is lifted off the silicon (carrier) substrate
- Related companies
 - Crystal solar, solexel
- Also relevant
 - ELTRAN process (Canon)



Example module

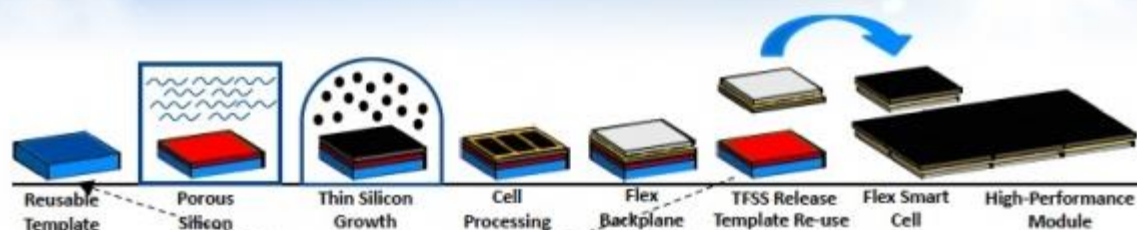


SOLEXEL®

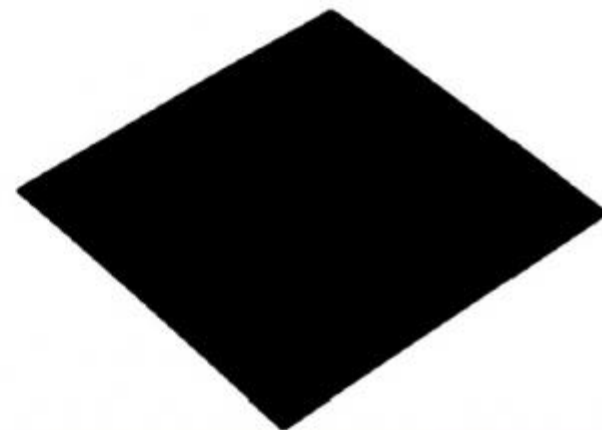


Disruptive Technology and Production Process Proven in Semi, Mapped and Scaled to Solar

SOLEXEL



- **Reusable Template** – Foundation for Thin Cell Processing; Reusable >100x
- **Releasable Thin Mono-Crystalline-Silicon** – 10x to 15x Less Si Usage vs. Traditional
- **Back Contact/Back-Junction Cell Design** – 3%+ Points Higher Efficiency vs. Traditional
- **Planar Flex Backplane** – Strength & Support for Cell; Smart Cells for **High Energy Yield**
- **Module** – Full-Square 156 x 156 mm² Cell Boosts Module Power, All-Black Aesthetics

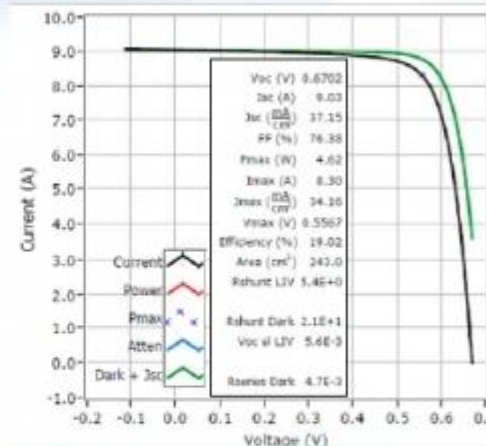


Example module

World Record 156 mm x 156 mm Full-Square Cell Efficiency
Using Ultrathin (35 μm) Epitaxial Silicon Absorber



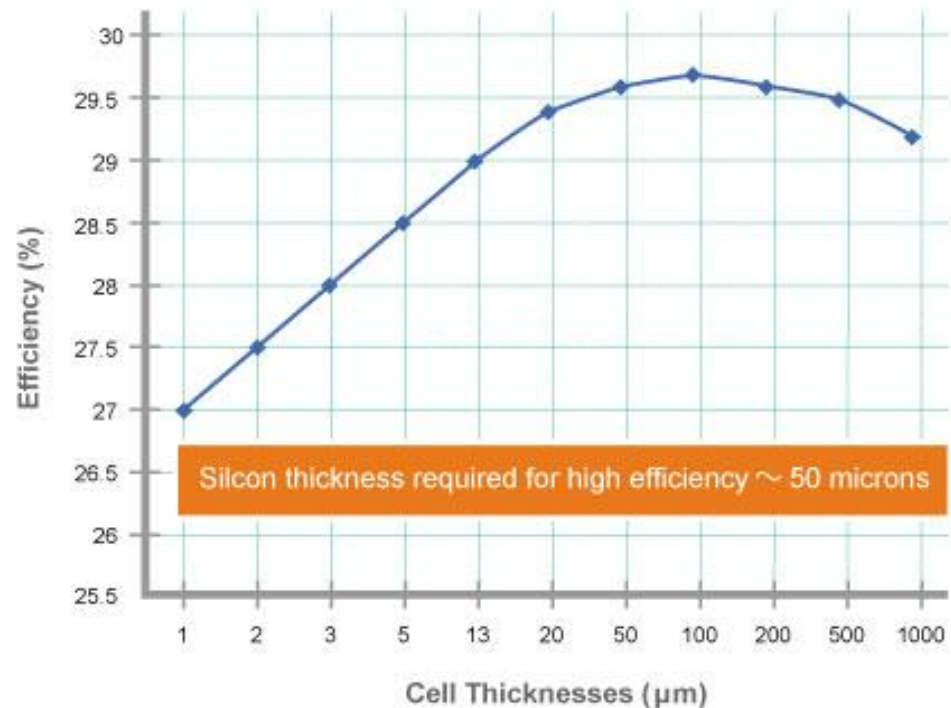
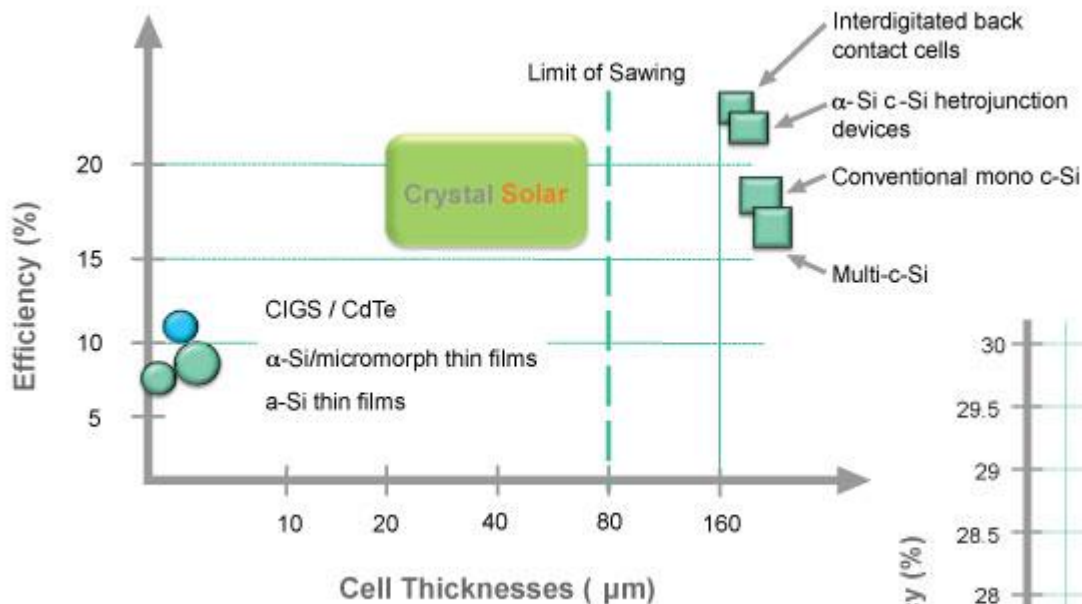
Cell Efficiency = 19.02%



- 156 x 156 mm² full-square cell (243 cm²)
- 35 μm epitaxial silicon
- Voc = 670 mV
- Jsc = 37.15 mA/cm²
- FF = 76.38%
- Cell Power = 4.6 Wp; I_{sc} = 9.03 A

Intersolar North America, 11 July 2012 (5)

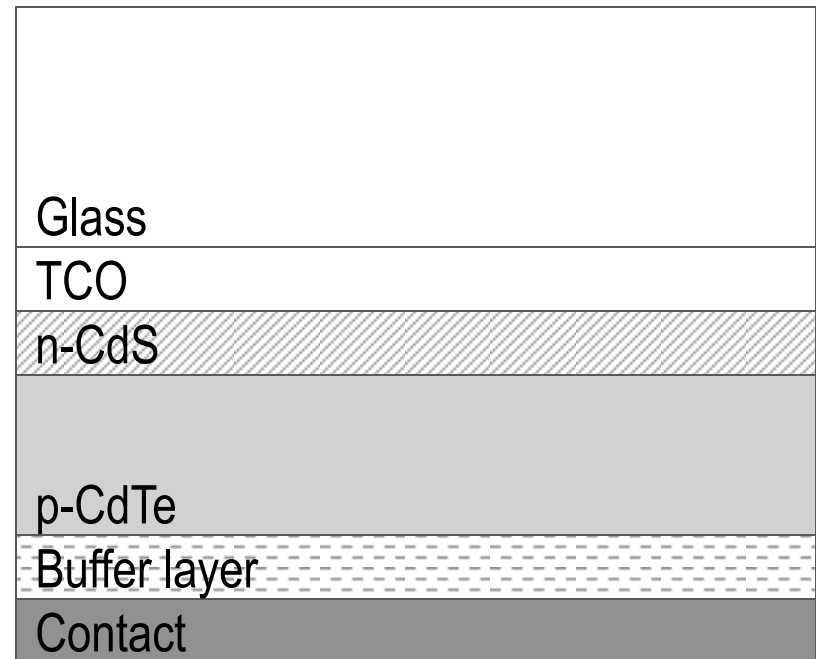
Example module



Alternative thin film solar cells

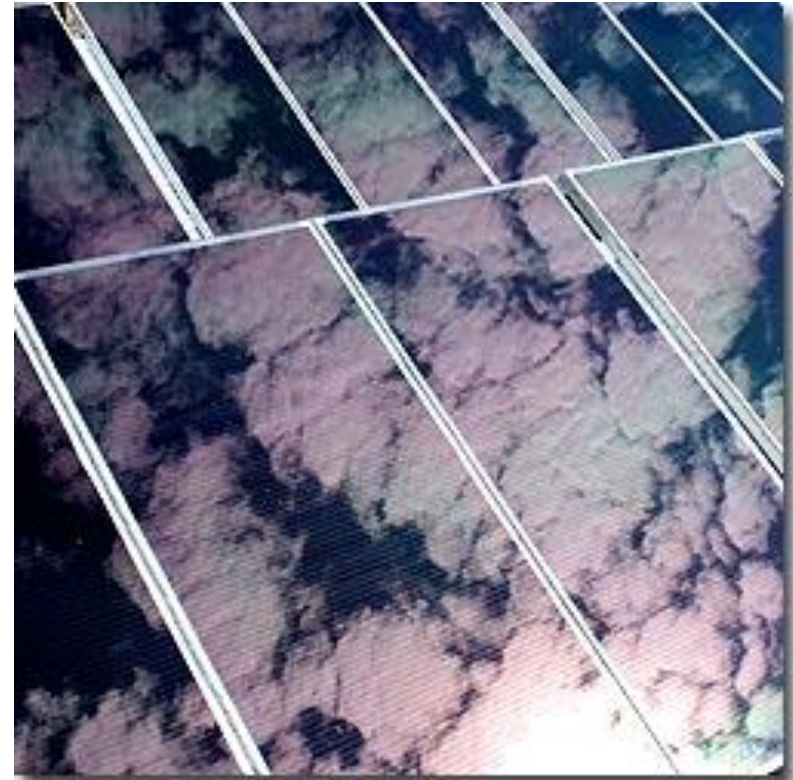
CdTe solar cells

- Heterojunction solar cell
 - n-type CdTe is hard to make
 - Best p-n CdTe homojunction cell: ~ 13% efficiency
 - CdTe/CdS heterojunction: 21.0%
- Solar cell structure
 - CdS buffer / window layer
 - CdTe absorber layer
- Band gap energies
 - CdTe: 1.45 eV
 - CdS: 2.4 eV



CdTe solar cells

- Fabrication techniques
 - Close spaced sublimation (CSS) used in the industry for CdTe formation
 - Chemical bath deposition typically used for depositing CdS
 - CVD, screen-printing, electrodeposition, spray pyrolysis and sputtering other candidates
- Company
 - First Solar



First Solar

CdTe solar cells

- Cadmium is **not** the greenest of elements
 - Toxic
 - Environmentally risky
 - Politically unpopular
- However, very little Cd is actually used for each module, and only in a bound state
- One serious challenge: response to fires

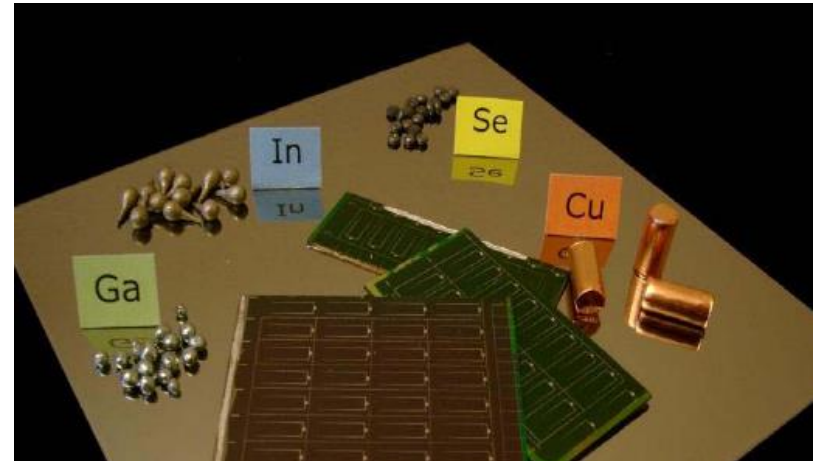


www.wikipedia.org

CIS/CIGS

- What is CIS and CIGS?
 - $\text{CIGS} = \text{CuIn}_{1-x}\text{Ga}_x\text{Se}_2$
 - $\text{CIS} = \text{CuInS}_2$
- Exhibit a chalcopyrite material structure
- Band gap energies
 - CIS: 1.5 eV
 - CIGS: $\sim 1.0 - 1.25$ eV
- Tunable band gap energy

$$E_g [\text{eV}] = 1.02 + 0.67x + bx(x-1)$$
$$x = \text{Ga}/(\text{In}+\text{Ga}), b \sim 0.1 - 0.2$$

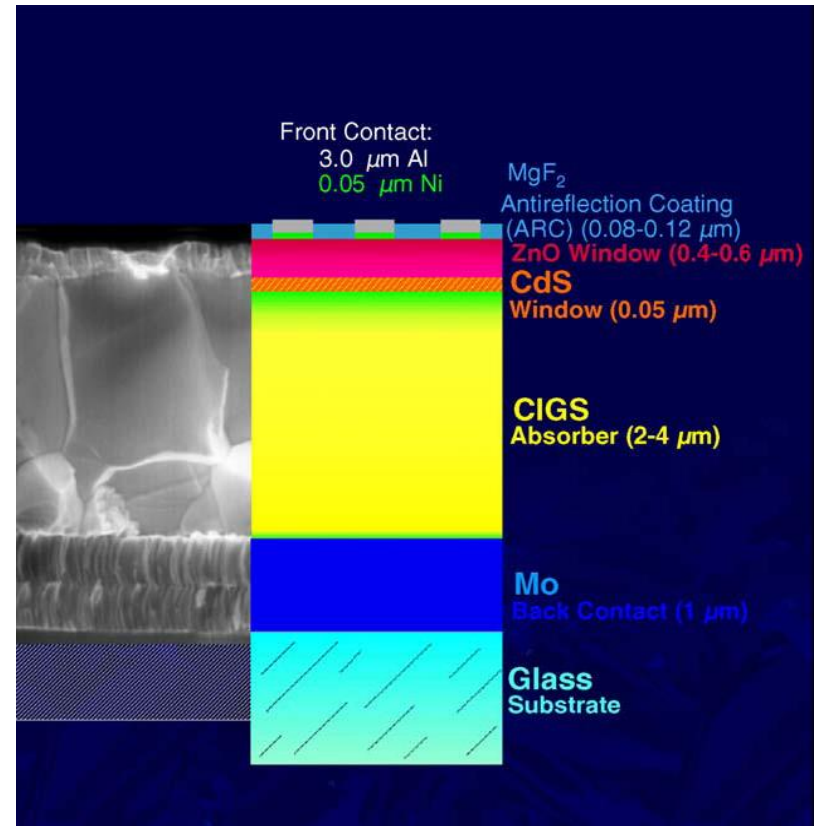


- 1.25 eV seems to be the maximum usable value before resistive losses caused by Ga become dominant

M. Edoff – ÅSC

CIS/CIGS

- Heterojunction solar cells perform better than homojunctions
- Record efficiency: 21.7% (Solar Frontier)



L. Kazmersky – NREL

Challenges

- Moisture is harmful for CIGS cells
- CdS should be replaced by other compounds
 - E.g. ZnO, [Zn,Mg]O, In₂S, ZnS
 - Work at ÅSC has shown that ZnO deposited by ALD gives improved blue response when compared with CdS
- Little In available
- Poor red response
- Recombination at heterojunction

«Kesterites»

- CZTS, a substitutional alloy
- Record efficiency 10.0% (UNSW)

Making CIGS modules

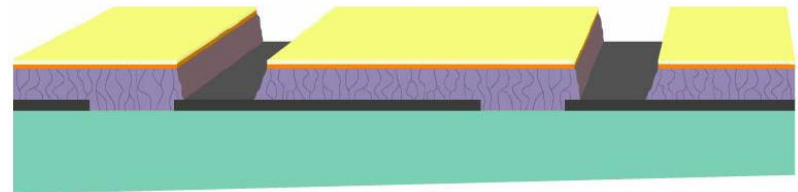
1. The float glass substrate is washed
2. Deposition of Mo back contact by sputtering
3. Patterning of the back contact by laser scribing



L. Stolt – ÅSC/Solibro AB

Making CIGS modules

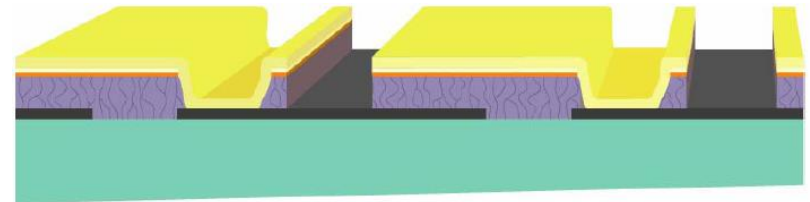
4. The CIGS-layer ($\text{Cu}(\text{InGa})\text{Se}_2$) is deposited by co-evaporation
5. Coating of ultra-thin buffer layers (50 nm) of CdS and ZnO
6. These semiconductor layers are patterned using a mechanical stylus



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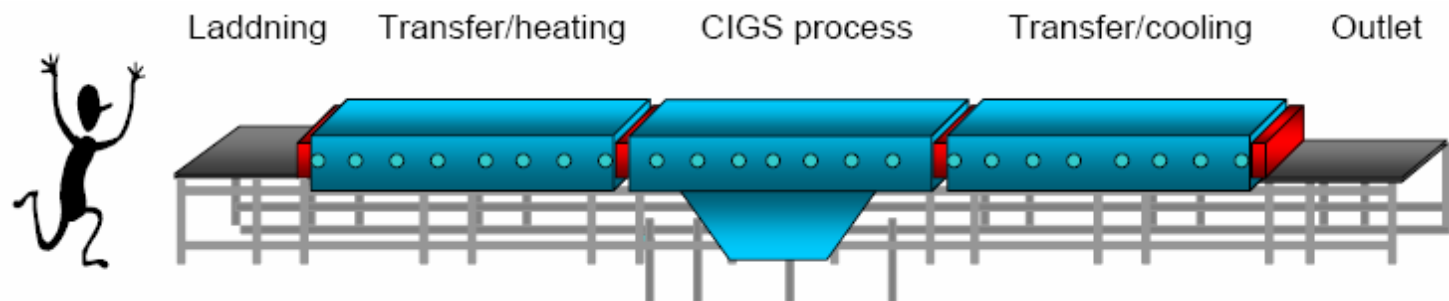
Making CIGS modules

7. A front contact of Al-doped ZnO is sputter-deposited
8. The front contact is patterned using a mechanical stylus



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Making CIGS modules



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Making CIGS modules

- 9. Edge deletion
- 10. Edge tabbing
- 11. Lamination
- 12. Framing
- 13. Junction box

Perovskites?

nature
photonics

ARTICLES

PUBLISHED ONLINE: 5 MAY 2013 | DOI: 10.1038/NPHOTON.2013.80

Efficient inorganic–organic hybrid heterojunction solar cells containing perovskite compound and polymeric hole conductors

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Efficiency

Received: 12 May 2017 | Accepted: 30 May 2017

DOI: 10.1002/ep.2909

WILEY

ACCELERATED PUBLICATION

Solar cell efficiency tables (version 50)

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TABLE 1 Confirmed single-junction terrestrial cell and submodule efficiencies measured under the global AM1.5 spectrum (1000 W/m²) at 25°C (IEC 60904-3: 2008, ASTM G-173-03 global). New entries in bold type

Classification	Efficiency (%)	Area (cm ²)	V _{oc} (V)	J _{sc} (mA/cm ²)	Fill Factor (%)	Test Centre (date)	Description
<u>Silicon</u>							
Si (crystalline cell)	26.7 ± 0.5	79.0 (db)	0.738	42.65 ^a	84.9	AIST (3/17)	Kaneka, n-type rear IBC ⁵
Si (multicrystalline cell)	21.9 ± 0.4 ^b	4.0003 (t)	0.6726	40.76 ^a	79.7	FhG-ISE (2/17)	FhG-ISE, n-type ⁶
Si (thin transfer submodule)	21.2 ± 0.4	239.7 (ap)	0.687 ^c	38.50 ^{c,d}	80.3	NREL (4/14)	Solexel (35 µm thick) ⁷
Si (thin film minimodule)	10.5 ± 0.3	94.0 (ap)	0.492 ^c	29.7 ^c	72.1	FhG-ISE (8/07) ^e	CSG Solar (<2 µm on glass) ⁸
<u>III-V cells</u>							
GaAs (thin film cell)	28.8 ± 0.9	0.9927 (ap)	1.122	29.68 ^f	86.5	NREL (5/12)	Alta Devices ⁹
GaAs (multicrystalline)	18.4 ± 0.5	4.011 (t)	0.994	23.2	79.7	NREL (11/95)	RTI, Ge substrate ¹⁰
InP (crystalline cell)	24.2 ± 0.5 ^b	1.008 (ap)	0.939	31.15 ^a	82.6	NREL (9/12)	NREL ¹¹
<u>Thin film chalcogenide</u>							
CIGS (cell)	21.7 ± 0.5	1.044 (db)	0.718	40.70 ^a	74.3	AIST (1/17)	Solar Frontier ¹²
CdTe (cell)	21.0 ± 0.4	1.0623 (ap)	0.8759	30.25 ^d	79.4	Newport (8/14)	First Solar, on glass ¹³
CZTS (cell)	10.0 ± 0.2	1.113 (db)	0.7083	21.77 ^a	65.1	NREL (3/17)	UNSW ¹⁴
<u>Amorphous/microcrystalline</u>							
Si (amorphous cell)	10.2 ± 0.3 ^{a,b}	1.001 (db)	0.896	16.36 ^d	69.8	AIST (7/14)	AIST ¹⁵
Si (microcrystalline cell)	11.9 ± 0.3 ^b	1.044 (db)	0.550	28.72 ^a	75.0	AIST (2/17)	AIST ¹⁶
<u>Perovskite</u>							
Perovskite (cell)	19.7 ± 0.6 ^{a,h}	0.9917 (db)	1.104	24.67 ⁱ	72.3	Newport (3/16)	KRICT/UNIST ¹⁷
Perovskite (minimodule)	16.0 ± 0.4 ^{a,h}	16.29 (ap)	1.029 ^c	19.51 ^{c,a}	76.1	Newport (4/17)	Microquanta, 6 serial cells ¹⁸
<u>Dye sensitised</u>							
Dye (cell)	11.9 ± 0.4 ⁱ	1.005 (db)	0.744	22.47 ^k	71.2	AIST (9/12)	Sharp ¹⁹
Dye (minimodule)	10.7 ± 0.4 ⁱ	26.55 (db)	0.754 ^c	20.19 ^{c,j}	69.9	AIST (2/15)	Sharp, 7 serial cells ¹⁹
Dye (submodule)	8.8 ± 0.3 ⁱ	398.8 (db)	0.697 ^c	18.42 ^{c,m}	68.7	AIST (9/12)	Sharp, 26 serial cells ²⁰
<u>Organic</u>							
Organic (cell)	11.2 ± 0.3 ⁿ	0.992 (db)	0.780	19.30 ^d	74.2	AIST (10/15)	Toshiba ²¹
Organic (minimodule)	9.7 ± 0.3 ⁿ	26.14 (db)	0.806	16.47 ^{c,j}	73.2	AIST (2/15)	Toshiba (8 series cells) ²²

TABLE 2 Confirmed multiple-junction terrestrial cell and submodule efficiencies measured under the global AM1.5 spectrum (1000 W/m²) at 25°C (IEC 60904-3: 2008, ASTM G-173-03 global). New entries in bold type

Classification	Efficiency (%)	Area (cm ²)	Voc (V)	Jsc (mA/cm ²)	Fill Factor (%)	Test Centre (date)	Description
<u>III-V Multijunctions</u>							
5 junction cell (bonded) (2.17/1.68/1.40/1.06/0.73 eV)	38.8 ± 1.2	1.021 (ap)	4.767	9.564	85.2	NREL (7/13)	Spectrolab, 2-terminal ²³
InGaP/GaAs/InGaAs	37.9 ± 1.2	1.047 (ap)	3.065	14.27 ^a	86.7	AIST (2/13)	Sharp, 2 term. ²⁴
GaInP/GaAs(monolithic)	31.6 ± 1.5	0.999 (ap)	2.538	14.18 ^b	87.7	NREL (1/16)	Alta Devices, 2 term. ²⁵
<u>Multijunctions with c-Si</u>							
GaInP/GaAs/Si (mech. stack)	35.9 ± 0.5 ^c	1.002 (da)	2.52/0.681	13.6/11.0	87.5/78.5	NREL (2/17)	NREL/CSEM/EPFL, 4-term ^{2,6}
GaInP/GaAs/Si (wafer bonded)	31.3 ± 1.1 ^c	3.981 (ap)	3.046	11.7 ^d	87.5	PhG-ISE (3/17)	Fraunhofer ISE, 2-term. ^{2,7}
GaInP/GaAs/Si (monolithic)	19.7 ± 0.7 ^c	3.943 (ap)	2.323	10.0 ^e	84.3	PhG-ISE (8/16)	Fraunhofer ISE ²⁰
GaAs/Si (mech. stack)	32.8 ± 0.5 ^c	1.003 (da)	1.09/0.683	28.9/11.1	85.0/79.2	NREL (12/16)	NREL/CSEM/EPFL, 4-term ^{2,6}
Perovskite/Si (monolithic)	23.6 ± 0.6 ^f	0.990 (ap)	1.651	18.09 ^g	79.0	NREL (8/16)	Stanford/ASU ²⁹
GaInP/GaInAs/Ge; Si(spectral split minimodule)	34.5 ± 2.0	27.83 (ap)	2.66/0.65	13.1/9.3	85.6/79.0	NREL (4/16)	UNSW/Azur/Trina, 4-term. ³⁰
<u>a-Si/nc-Si Multijunctions</u>							
a-Si/nc-Si/nc-Si (thin-film)	14.0 ± 0.4 ^{h,c}	1.045 (da)	1.922	9.94 ^a	73.4	AIST (5/16)	AIST ³¹
a-Si/nc-Si (thin-film cell)	12.7 ± 0.4 ^{h,c}	1.000(da)	1.342	13.45 ^h	70.2	AIST (10/14)	AIST ^{25,32}

TABLE 3 Confirmed terrestrial module efficiencies measured under the global AM1.5 spectrum (1000 W/m^2) at a cell temperature of 25°C (IEC 60904-3:2008, ASTM G-173-03 global). New entries in bold type

Classification	Effic. (%)	Area (cm^2)	V_{oc} (V)	I_{sc} (A)	FF (%)	Test Centre (date)	Description
Si (crystalline)	24.4 ± 0.5	13177 (da)	79.5	5.04 ^a	80.1	AIST (9/16)	Kaneka (108 cells) ⁵
Si (multicrystalline)	19.9 ± 0.4	15143 (ap)	78.87	4.795 ^a	79.5	RhG-ISE (10/16)	Trina Solar (120 cells) ^{3,3}
GaAs (thin film)	24.8 ± 0.5	865.3 (ap)	11.07	2.288 ^b	84.7	NREL (11/16)	Alta Devices ^{3,4}
CIGS (Cd free)	19.2 ± 0.5	841 (da)	48.0	0.456 ^b	73.7	AIST (1/17)	Solar Frontier (70 cells) ^{3,5}
CIGS (large)	15.7 ± 0.5	9703 (ap)	28.24	7.254 ^c	72.5	NREL (11/10)	Miasole ^{3,6}
CdTe (thin-film)	18.6 ± 0.6	7038.8 (ap)	110.6	1.533 ^d	74.2	NREL (4/15)	First Solar, monolithic ^{3,7}
a-Si/nc-Si (tandem)	12.3 ± 0.3^e	14322 (t)	280.1	0.902 ^f	69.9	ESTI (9/14)	TEL Solar, Trubbach Labs ^{3,8}
Organic	8.7 ± 0.3^g	802 (da)	17.47	0.569 ^h	70.4	AIST (5/14)	Toshiba ²²
<u>Multijunction</u>							
InGaP/GaAs/InGaAs	31.2 ± 1.2	968 (da)	23.95	1.506	83.6	AIST (2/16)	Sharp (32 cells) ^{3,9}

TABLE 4 "Notable exceptions": "Top dozen" confirmed cell and module results, not class records measured under the global AM1.5 spectrum (1000 Wm⁻²) at 25°C (IEC 60904-3: 2008, ASTM G-173-03 global). New entries in bold type

Classification	Efficiency (%)	Area (cm ²)	V _{oc} (V)	J _{sc} (mA/cm ²)	Fill Factor (%)	Test Centre (date)	Description
<u>Cells (silicon)</u>							
Si (crystalline)	25.0 ± 0.5	4.00 (da)	0.706	42.7 ^a	82.8	Sandia (3/99) ^b	UNSW p-type PERC top/rear contacts ⁴⁰
Si (crystalline)	25.7 ± 0.5 ^c	4.017 (da)	0.7249	42.54 ^d	83.3	RhG-ISE (3/17)	RhG-ISE, n-type top/rear contacts ⁴¹
Si (large)	26.6 ± 0.5	179.74 (da)	0.7403	42.5 ^d	84.7	RhG-ISE (11/16)	Kaneka, n-type rear IBC ⁵
Si (multicrystalline)	21.3 ± 0.4	242.74 (t)	0.6678	39.80 ^e	80.0	RhG-ISE (11/15)	Trina Solar, large p-type ⁴²
<u>Cells (III-V)</u>							
GaInP	21.4 ± 0.3	0.2504 (ap)	1.4932	16.31 ^f	87.7	NREL (9/16)	LG Electronics, high bandgap ⁴³
<u>Cells (chalcogenide)</u>							
CIGS (thin-film)	22.6 ± 0.5	0.4092 (da)	0.7411	37.76 ^f	80.6	RhG-ISE (2/16)	ZSW on glass ⁴⁴
CIGSS (Cd free)	22.0 ± 0.5	0.512 (da)	0.7170	39.45 ^f	77.9	RhG-ISE (2/16)	Solar Frontier on glass ^{1,2}
CdTe (thin-film)	22.1 ± 0.5	0.4798 (da)	0.8872	31.69 ^g	78.5	Newport (11/15)	First Solar on glass ⁴⁵
CZTSS (thin-film)	12.6 ± 0.3	0.4209 (ap)	0.5134	35.21 ^h	69.8	Newport (7/13)	IBM solution grown ⁴⁶
CZTS (thin-film)	11.0 ± 0.2	0.2339(da)	0.7306	21.74 ^d	69.3	NREL (3/17)	UNSW on glass ⁴⁴
<u>Cells (other)</u>							
Perovskite (thin-film)	22.1 ± 0.7 ⁱ	0.0946 (ap)	1.105	24.97 ⁱ	80.3	Newport (3/16)	KRICT/UNIST ^{1,7}
Organic (thin-film)	12.1 ± 0.3 ^k	0.0407 (ap)	0.8150	20.27 ^d	73.5	Newport (2/17)	Phillips 66

Abbreviations: CIGSS, CuInGaSSe; CZTSS, Cu₂ZnSnS_{4-y}Se_y; CZTS, Cu₂ZnSnS₄; (ap), aperture area; (t), total area; (da), designated illumination area; AIST, Japanese National Institute of Advanced Industrial Science and Technology; NREL, National Renewable Energy Laboratory; RhG-ISE, Fraunhofer-Institut für Solare Energiesysteme.

TABLE 5 "Direct beam" terrestrial concentrator cell and module efficiencies measured under the ASTM G-173-03 direct AM1.5 spectrum at a cell temperature of 25°C. New entries in bold type

Classification	Effic. (%)	Area (cm ²)	Intensity ^a (suns)	Test Centre (date)	Description
Single cells					
GaAs	29.3 ± 0.7 ^b	0.09359 (da)	49.9	NREL (10/16)	LG Electronics
Si	27.6 ± 1.2 ^c	1.00 (da)	92	RhG-ISE (11/04)	Amonix back-contact ⁴³
CIGS (thin-film)	23.3 ± 1.2 ^{d,e}	0.09902 (ap)	15	NREL (3/14)	NREL ⁴⁹
Multijunction cells					
GalnP/GaAs; GalnAsP/GalnAs	46.0 ± 2.2 ^f	0.0520 (da)	508	AIST (10/14)	Soitec/CEA/RhG-ISE 4j bonded ⁵⁰
GalnP/GaAs/GalnAs/GalnAs	45.7 ± 2.3 ^{d,g}	0.09709 (da)	234	NREL (9/14)	NREL, 4j monolithic ⁵¹
InGaP/GaAs/InGaAs	44.4 ± 2.6 ^h	0.1652 (da)	302	RhG-ISE (4/13)	Sharp, 3j inverted metamorphic ⁵²
GalnP/GalnAs	35.1 ± 1.1 ⁴⁴	0.05376 (da)	407	RhG-ISE (3/17)	Fraunhofer ISE 2j ⁵³
Minimodule					
GalnP/GaAs; GalnAsP/GalnAs (wafer bonded)	43.4 ± 2.4 ^{d,i}	18.2 (ap)	340 ^k	RhG-ISE (7/15)	Fraunhofer ISE 4j (lens/cell) ⁵⁴
Submodule					
GalnP/GalnAs/Ge; Si	40.6 ± 2.0 ⁿ	287 (ap)	365	NREL (4/16)	UNSW 4j split spectrum ⁵⁵
Modules					
Si	20.5 ± 0.8 ^d	1875 (ap)	79	Sandia (4/89) ^k	Sandia/UNSW/ENTECH (12 cells) ^{5,6}
Three junction (3j)	35.9 ± 1.8 ^m	1092 (ap)	N/A	NREL (8/13)	Amonix ⁵⁷
Four junction (4j)	38.9 ± 2.5 ⁿ	812.3 (ap)	333	RhG-ISE (4/15)	Soitec ⁵⁸
"Notable Exceptions"					
Si (large-area cell)	21.7 ± 0.7	20.0 (da)	11	Sandia (9/90) ^k	UNSW laser grooved ⁵⁹
Luminescent minimodule	7.1 ± 0.2	25(ap)	2.5 ^k	ESTI (9/08)	ECN Petten, GaAs cells ⁴⁰

Concluding remarks

- Many alternatives to crystalline silicon solar cells have been proposed
- Several thin film technologies, as well as some electrochemical solar cells have been industrialized
- What impact these technologies will have on the overall solar cell market both in the short and long run is uncertain
- Main challenges:
 - Scale-up in size and production volume
 - Increases in module efficiency
 - Stability
 - Material properties and, for very large production volumes, availability